Walchand College of Engineering, Sangli (Government Aided Autonomous Institute)

	AY 2023-24
	Course Information
Programme	B. Tech. (Electronics Engineering)
Class, Semester	First Year B. Tech., Sem I
Course Code	7MA101
Course Name	Engineering Mathematics-I
Desired Requisites:	Mathematics course at Higher Secondary Junior College

Teachi	ng Scheme		Examination S	cheme (Marks)	
Lecture	3 Hrs/week	MSE	ISE	ESE	Total
Tutorial	1 Hrs/week	30	20	50	100
	and low - immediate		Cred	its: 04	

	Course Objectives	
1	Introduce the basic concepts required to understand, construct, solve and interpre of differential equation.	t various types
2	Improve the Mathematical skill for enhancing logical thinking power of students	
3	Acquire knowledge with a sound foundation in Mathematics and prepare them for	or graduate.
4		
	Course Outcomes (CO) with Bloom's Taxonomy Level	
At the	end of the course, the students will be able to,	
C01	Explain mathematical concepts in engineering field.	Understanding
CO2	Solve engineering and scientific problems.	Applying
CO3	Applying the Mathematical concept in Engineering field	Applying
C04		

Module	Module Contents	Hours
I	Matrices Rank of matrix, Homogeneous and non-homogeneous linear equations, Eigen values, Eigen vectors, Cayley Hamilton theorem, Diagonalizations of matrices.	6
11	Partial Differentiation and its application Partial derivative, chain rule for partial differentiation, Euler's theorem for homogeneous and non-homogeneous function, Jacobian, Error and approximation, maxima and minima of function of two variables	8
[]]	Complex Number Polar form of complex number, Argand's diagram, De Moiver's theorem, roots of complex number, Hyperbolic function, relation between circular and hyperbolic function.	7

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1	Useful Links https://nptel.ac.in/courses/111105121	
	And the first of the second of the second of the second state.	
4	B.V.Ramana, "Higher Engineering Mathematics ", The McGraw Hill companies	, 2006.
3	H. K. Dass, "Advanced Engineering Mathematics", S. Chand & Company Lt 2014.	d., 1 st Editio
2	Wylie C.R "Advanced Engineering Mathematics",., Tata McGraw Hill P Edition 1999.	
1	Erwin Kreyszig, "Advanced Engineering Mathematics", Wiley Eastern Limit 10 th Edition, 2015.	
	References	
4		
3 4		
2	B.S. Grewal "Higher Engineering Mathematics", , Khanna Publication, 44th E	dition, 2017.
1	P. N. and J. N. Wartikar "A Text Book of Applied Mathematics, Vol I and II, Prakashan, Pune, 2006.	
	Textbooks	
	The second se	_
VI	Rolle's theorem, Mean value theorem, Taylor's and Maclaurin's theorem with remainders	5
	Calculus	
V	Numerical Solution of Ordinary Differential Equations of first orderand first degree:Numerical Solution by (i) Taylor's series method (ii) Euler's method (iii)Modified Euler's method (iv) Runge- Kutta fourth order method	6
IV	Exact, Linear, Bernoulli's equations, Euler's equations, Orthogonal trajectory, applications to simple electric circuit.	7

						CO-PC) Mapp	oing						
	Programme Outcomes (PO)												PS	30
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2			1								. ~		-
CO2	2			1										
CO3	2			1										
CO4												-		

The strength of mapping is to be written as 1: Low, 2: Medium, 3: High Each CO of the course must map to at least one PO.

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Wale		of Engineering, Statute (Sangli					
				2023-24						
			Course	Information						
Progr	amme		B. Tech. (Electror							
	Semester		First Year B. Tech	e 0:						
	e Code		7CH102							
	e Name		Engineering Chen	nistrv						
	ed Requis	ites:		at Secondary and High	ner secondary le	vel				
	<u></u>	0.1								
	Teaching	3 Hrs/week	MSE	Examination School		Total				
Lectur Tutor		0Hrs/week			ESE 50					
lutor	lai	UHIS/Week	30	20	50	100				
				Credits	. 3					
			Course	e Objectives						
1	1	student familiar ully in practice.	with engineering p	roperties associated w	th different mat	erials to use them				
2	To provi			haracterization and che	mical analysis f	or using materials				
	1		<u> </u>	vith Bloom's Taxonor	ny Level					
At the	end of the	course, the stud	ents will be able to,							
со		Bloom's Taxonomy Description								
CO1				analysis/ Batteries, fu		^				
			hase rule. Types o ustrial applications	f corrosion, Mechanis	m II	Understanding				
CO2	SEM,TE	EM and AFM, p		beam spectrophotomete hermo grams/ Batterie ode, GLC setup		Understanding				
CO3		types of chemi- on, Batteries	cal analysis, hard	water, Chromatograph	y. II	Understanding				
CO4			of solutions, % of fic values, % weigh	analyte gravimetrical at loss TGA	y, III	Applying				
Modu	ıle		Module C	Contents		Hours				
				cal Analysis Part A: `						
Ι	conc Defi	entration of solnition of terms a	ution & Numerica	ication, Different w l problems. Standard metry. Classification of problems.	s and its types	, 7				
Π	Mod Instr Grav pH Instr Intro	ule 2. General rument imetry and its re metry, potentior umentation, Cal duction to GLC,	principles of chements, applicanetry, Single bear ibration, Application Introduction for Sl	tions and Numerical p n spectrophotometry on Chromatography a EM, TEM, AFM and nental and non-instrum	roblems. w.r.t. Principle nd its types & its applications.	6				

	Module 2. General principles of chemical Analysis Part B: Gravimetry &	
	Instrument	
т	Gravimetry and its requirements, applications and Numerical problems.	6
II	pH metry, potentiometry, Single beam spectrophotometry w.r.t. Principle, Instrumentation, Calibration, Application Chromatography and its types &	
	Introduction to GLC, Introduction for SEM, TEM, AFM and its applications.	
	Advantages and Disadvantages of instrumental and non-instrumental methods.	
	Modules 3. Water Chemistry - Natural sources of water, Impurities in natural	
	water. Water quality parameters Hardness- Definition, Causes, Types,	
	Expressing hardness, units to measure hardness, Numerical problems on	
III	hardness calculation, ill effects of hard water in steam generation, Alkalinity,	7
	Chloride, Dissolved oxygen (DO), Biological Oxygen Demand (BOD) and	
	Chemical Oxygen Demand (COD) its significance. Ion exchange method of	
	water softening	
	Module 4 : Corrosion Science	
	Definition of corrosion, Types of corrosion, Dry & wet corrosion,	
	Electrochemical & Galvanic series & its importance, Mechanism of Hydrogen	
IV	evolution and Oxygen absorption corrosion, Factors influencing rate of	7
	corrosion, Various methods for protection from corrosion viz. Surface	
	coatings(Electroplating, Galvanizing, Tinning) Cathodic and Anodic	
	protection,	
	Module 5. Battery & Fuel cell: Terms in battery and fuel cell: Anode,	
	Cathode, Cell, Battery, Electrode Electrolyte, Types of batteries: Construction,	
V	working, uses and advantages of primary cells: Dry Cell: (Leclanche Cell), Lithium cells: Lithium cells with solid cathode Lithium cells with liquid	6
	cathode, Secondary cell: Lead – Acid cell, Nickel – Cadmium Cell, Hydrogen	
	oxygen fuel cell, Methyl Alcohol- Oxygen (Alkaline Fuel Cell)	
	Module 6- Phase Rule: Gibbs phase rule, Explanation of the terms Phase,	
	Component, Degree of freedom, Phase reactions, types of equilibrium,	
VI	equilibrium conditions. One component system-Water system, Sulphur system,	6
	Two component system- Lead Silver system, Application of Eutectic system,	
	Merit and Demerits of Phase rule.	
	Textbooks	
1	S.K. Singh, "Engineering Chemistry", New Age Publication, 3rd Edition, 2005.	
2	ShasiChawla, "Engineering Chemistry", DhanpatRai Publication, 3rd Edition, 20	
3	Jain P.C. and Jain Monika, "Engineering Chemistry", DhanpatRai Publication, 16	th Edition, 2013
	D. 4	
1	References	
1	O G Palanna, "Engineering Chemistry" Tata McGraw Hill 2009.Mendham, R.C. Denney, J.D. Barnes, M.J.K Thomas, "Quantitative Chemical a	malysis" Vogel's
2	Pearson Education, 6th Edition, 2008.	marysis, vogers
3	S.S Dara, "Engineering Chemistry" S. Chand and Company 2008.	
4	B Viswanathan M. AuliceScibioh" Fuel Cell: Principle and Applications" Unive	rsities Press 2009
5	Askeland and Phule, "The Science and Engineering of Materials" Thomson	
5	Edition ,2003	
	Useful Links	
1	https://edu.rsc.org/resources	
2	https://onlinecourses.nptel.ac.in/noc21_cy49/preview	
3	https://onlinelibrary.wiley.com/doi/book/10.1002/9780470697702	
4	https://nptel.ac.in/courses/113108051	
5	https://www.youtube.com/watch?v=L2VSOccUrSk	
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					CC)-PO N	Aappir	ng						
		Programme Outcomes (PO)											PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3					1								
CO2	3													
CO3	3							1						
CO4	3	1												
The strength of	of mapp	ing is t	o be wi	ritten as	s 1: Lov	<i>w</i> , 2: M	edium,	3: Hig	h					
				. 1	, D	0								

Each CO of the course must map to at least one PO.

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISEshall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments, surprise or declared test etc.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

				ed Autonomous Institute)		and the second					
			AY	2023-24							
			Course	Information							
Progra	ımme		First Year B. Tech. (Electronics Branch)								
Class,	Semester		First Year B. Tech., Sem I								
Course			7EL106								
	e Name		Basic Electrical	Engineering	Halley						
Desired	d Requisit	tes:	NIL								
	Feaching			Examination Sche	The second s						
Lectur		3 Hrs/week	MSE	ISE	ESE	Total					
Tutoria	al	-	30	20	50	100					
			L	Credits:	3						
			~								
1	Th	an inter let		e Objectives							
1 2				e electrical and magneti nstruction and working		ahinaa					
				em, lamps and low volta							
				with Bloom's Taxonom		components.					
At the e	end of the		ents will be able t								
~~		~			Bloom's	Bloom's					
CO		Course	e Outcome Stater	nent/s	Taxonomy Level	Taxonomy					
CO1	Describe	basic concepts	in Electrical Engi	Description Understanding							
		The second s	truction and work	<u> </u>							
	machine.			Understanding							
CO3	Solve elec	ctrical and mag	netic circuits.		III	Applying					
Madal			N. I.I.	7 4 4							
Modul		le 1: DC Circu	Module (Contents	,	Hours					
				elements, KCL and KV	VI Star- delta						
Ι				sources. Thevenin,		8					
			num powers trans								
		le 2: AC Circu									
п	Repre	sentation of	sinusoidal wave	forms, peak, RMS v	alues, phasor						
II	circuit	ts consisting of	R. L. C. RL. RC	nt power. Analysis of s RLC (series and paralle	el) circuits and	7					
	three-	phase balanced	circuits. Voltage a	and current relations in s	tar and delta.						
	Modu	le 3: DC Mach	ines		n fille angebreak se						
III	Const	Construction, working principle and types of DC generator and Motor. Voltage and speed control methods, Speed-Torque characteristics. Principle,									
III	Voltag	ge and speed co	ontrol methods, Sp	or of Permanent Magnet	tics. Principle,	6					
			motors and unive		of DC Ivioloi,						
	Modu	le 4: Transform	ners								
IV	Review	w of DC & AC	Magnetic circuits	s, Construction, working	g principle and	6					
	types	of single-phase	transformer, open	circuit and short circui	t tests: Losses,	U					
	Modu	le 5: AC Macl	iciency and regula	tion. Autotransformer.							
				of single and three- pl	ase induction						
V	motor.	Types, torque	e- speed characte	ristics and applications	s of induction	6					
	motor,	Types of starte	ers, AC generator.	11							

Course Contents for B. Tech. Programme, Department of Electrical Engineering, AY 2023-24

	Module 6: Wiring, Electrical Installations and Components of LT Switchgear										
VI	Switch fuse unit, MCB, ELCB, MCCB. Types of wire and cables. Staircase, 6										
	Go-down and Domestic wiring, CFL, LED, Fluorescent tube. Lighting										
	schemes, Earthing, types of batteries, characteristics of batteries.										
	Textbooks										
1	D.C. Kulshreshtha, "Basic Electrical Engineering", 1st revised edition McGraw Hill, 2012.										
2	D.P Kothari and I.J Nagrath, "Basic Electrical Engineering", Tata McGraw Hill, 2010.										
3	B.L Theraja "A Textbook of Electrical Technology", S Chand Publication, 2013.										
	References										
1	V. D. Toro, "Electrical Engineering Fundamentals", Prentice Hall India, 1989.										
2	E. Hughes, "Electrical and Electronics Technology", Pearson, 2010.										
3	V. N. Mittle and Arvind Mittal, "Basic Electrical Engineering", 2nd edition, Tata McGra Hill.										
	Useful Links										
1	Basic Electrical Technology, IISc Bangalore, by Prof. L. Umanand										
1	Basic Electrical Technology, IISc Bangalore, by Prof. L. Umanan, "https://nptel.ac.in/courses/108108076"										

- Basic Electrical Technology, IIT Kharagpur, by Prof. N.K. De, Prof. G.D. Roy, Prof. T.K. Bhattacharya, "https://nptel.ac.in/courses/108105053"
 Fundamentals of Electrical Engineering, IIT Kharagpur, by Prof. Debapriya Das ,
- 3 Fundamentals of Electrical Engineering, III Kharagpur, by Prof. Debapriya Das, "https://nptel.ac.in/courses/108105112"

Programme Outcomes (PO)													PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3												1 - 10	
CO2	3									-				
CO3		3	2.5 6 2											

Each CO of the course must map to at least one PO.

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		Walc	chand College (Government Aided	of Engineerin l Autonomous Institu		
				2023-24	,	
			Course]	Information		
Progra	amme		B. Tech. (Electro	nics Engineering)		
Class,	Semester		First Year B. Tec	h., SemI		
Course	e Code		7EN101			
Course	e Name		Analog Electroni	cs		
Desire	d Requisi	tes:	12 th Physics			
,	Teaching	Scheme		Examination	Scheme (Marks)	
Lectur	re	3 Hrs/week	MSE	ISE	ESE	Total
Tutori	al	-	30	20	50	100
				Cre	dits: 2	
				Objectives		
1		¥			p-amp based circuits	· · · · · · · · · · · · · · · · · · ·
2			s used for analysis			
3			ls used for analysis			
4	10 expla		of and design methe Outcomes (CO) w			
At the	end of the		lents will be able to			
CO1				·	p-amp based circuits	. Apply
CO2		A	e of diode circuits,		<u> </u>	Analyze
CO3					and also with effec	tof
			p-amp on the circui			Analyze
CO4			nce of op-amp ba	ased waveform g	generators and volt	age Evaluate
	regulator	S.				
Modu	la		Modulo	Contents		Hours
wiodu		anduator Dia				nours
Ι			des and its Applica		nd full-wave rectif	
		man and a choice				ier 6
						ier, 6
			s; Zener diode, LEI			ier, 6
II	Basic Trans	ers and clamper es of Transistor distor structure,	s; Zener diode, LEI :: types (BJT, FET a	D, Photodiode and and MOSFET), tra	Solar Cell.	
II	Basic Trans biasir	ers and clamper s of Transistor distor structure, ag methods, trar	s; Zener diode, LEI : types (BJT, FET a sistor as a switch, 1	D, Photodiode and and MOSFET), tra	Solar Cell.	
II	Basic Trans biasir Tran	ers and clamper s of Transistor istor structure, ng methods, trar sistorized Amp	s; Zener diode, LEI : types (BJT, FET a sistor as a switch, b blifiers:	D, Photodiode and and MOSFET), tra Introduction to CM	Solar Cell. ansistor configuration AOS circuit.	ons, 6
II	Basic Trans biasir Tran Ampl	ers and clamper es of Transistor sistor structure, ag methods, tran sistorized Amp ifier fundamen	s; Zener diode, LEI types (BJT, FET a sistor as a switch, 1 blifiers: tals, small signal	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: comr	Solar Cell. ansistor configuration AOS circuit. non emitter amplif	ier,
	Basic Trans biasir Tran Ampl comn	ers and clamper es of Transistor istor structure, ag methods, trar sistorized Amp ifier fundamen non collector a	s; Zener diode, LEI types (BJT, FET a sistor as a switch, 1 blifiers: ttals, small signal mplifier; JFET/MC	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: comr DSFET common	Solar Cell. ansistor configuration AOS circuit.	ier,
	Basic Trans biasir Tran Ampl comm ampli	ers and clamper s of Transistor istor structure, ing methods, tran sistorized Amp ifier fundament non collector a fier, frequency	s; Zener diode, LEI types (BJT, FET a sistor as a switch, b blifiers: tals, small signal mplifier; JFET/MC response of amplifi	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: comr DSFET common	Solar Cell. ansistor configuration AOS circuit. non emitter amplif	ier,
III	Basic Trans biasir Tran Ampl comn ampli Oper	ers and clamper s of Transistor istor structure, ag methods, tran sistorized Amp ifier fundamen non collector a fier, frequency rational Amplif	s; Zener diode, LEI types (BJT, FET a ssistor as a switch, 1 blifiers: tals, small signal mplifier; JFET/MC response of amplifi ier	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers.	Solar Cell. ansistor configuration AOS circuit. non emitter amplif	ons, 6 ier, 8 ain 8
	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal	ers and clamper s of Transistor istor structure, ing methods, transistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp circu	s; Zener diode, LEI types (BJT, FET a sistor as a switch, 1 blifiers: ttals, small signal mplifier; JFET/MC response of amplifi fier guration, op-amp it analysis, invert	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: comr DSFET common ters. powering, feedbaing, non-invertin	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr	ier, 8 iits, 9
III	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli	ers and clamper s of Transistor istor structure, ing methods, transistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp circu ifier, difference	s; Zener diode, LEI types (BJT, FET a asistor as a switch, l blifiers: tals, small signal mplifier; JFET/MC response of amplifi fer guration, op-amp it analysis, invert amplifier, unity gai	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: comr DSFET common ters. powering, feedbaing, non-invertin	Solar Cell. ansistor configuration <u>AOS circuit.</u> non emitter amplif source/ common dr ck in op-amp circu	ier, 8 iits, 9
III IV	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a	ers and clamper s of Transistor istor structure, ing methods, tran sistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp circu ifier, difference mp Application	s; Zener diode, LEI types (BJT, FET a sistor as a switch, 1 olifiers: tals, small signal mplifier; JFET/MC response of amplifi ier guration, op-amp it analysis, invert amplifier, unity gai ns:	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers. powering, feedbai ing, non-invertin in buffer.	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ	ons, 6 ier, 8 ain 8 its, 9
III	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta	ers and clamper s of Transistor istor structure, ag methods, trar sistorized Amp ifier fundamen non collector a fier, frequency rational Amplif op-amp confi op-amp circu ifier, difference mp Application ge comparator,	s; Zener diode, LEI types (BJT, FET a nsistor as a switch, 1 blifiers: ttals, small signal mplifier; JFET/MC response of amplifi ier guration, op-amp it analysis, invert amplifier, unity gai ns : , Schmitt trigger c	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common ters. powering, feedba- ing, non-invertin in buffer.	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit	ons, 6 ier, 8 ain 8 its, 9
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III IV	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta feedb Regu	ers and clamper s of Transistor istor structure, ing methods, transistor sistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp confi op-amp circu fier, difference mp Application ge comparator, ack, types of os lated DC Power	s; Zener diode, LEI types (BJT, FET a sistor as a switch, 1 blifiers: tals, small signal mplifier; JFET/MC response of amplifi fer guration, op-amp it analysis, invert amplifier, unity gai ns: , Schmitt trigger c ccillator, RC oscilla er Supply:	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common ters. powering, feedba- ing, non-inverting in buffer. Eircuit, multivibra- tors, monolithic ti	Solar Cell. ansistor configuration <u>AOS circuit.</u> non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit mers (IC555).	ons, 6 ier, 8 ain 8 its, 9 ive 5
III IV V	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta feedb Regu Block	ers and clamper s of Transistor istor structure, ing methods, transistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp confi op-amp circu ifier, difference mp Application ge comparator, ack, types of os lated DC Power c diagram of re	s; Zener diode, LEI types (BJT, FET a asistor as a switch, 1 blifiers: tals, small signal mplifier; JFET/MC response of amplifi fer guration, op-amp p it analysis, invert amplifier, unity gai ns : , Schmitt trigger c ceillator, RC oscillator er Supply: egulated dc power	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers. powering, feedba- ing, non-invertin in buffer. vircuit, multivibra tors, monolithic ti supply, Zener d	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit	ons, 6 ier, 8 iits, 9 ive 5 tor, 6
III IV V	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta feedb Regu Block	ers and clamper s of Transistor istor structure, ing methods, transistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp confi op-amp circu ifier, difference mp Application ge comparator, ack, types of os lated DC Power c diagram of re	s; Zener diode, LEI types (BJT, FET a asistor as a switch, 1 blifiers: tals, small signal mplifier; JFET/MC response of amplifi fer guration, op-amp p it analysis, invert amplifier, unity gai ns : , Schmitt trigger c ceillator, RC oscillator er Supply: egulated dc power	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers. powering, feedba- ing, non-invertin in buffer. vircuit, multivibra tors, monolithic ti supply, Zener d	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit mers (IC555).	ons, 6 ier, 8 iits, 9 ive 5 tor, 6
III IV V	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta feedb Regu Block series	ers and clamper s of Transistor istor structure, ing methods, transistorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp confi op-amp circu ifier, difference mp Application ge comparator, ack, types of os lated DC Powe c diagram of re- s and shunt regu	s; Zener diode, LEI types (BJT, FET a asistor as a switch, I blifiers: tals, small signal mplifier; JFET/MC response of amplifi ier guration, op-amp p it analysis, invert amplifier, unity gai ns: , Schmitt trigger c ccillator, RC oscilla er Supply: egulated dc power lator, op-amp based Tex	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers. powering, feedba- ing, non-invertin in buffer. fircuit, multivibra tors, monolithic ti supply, Zener d d voltage regulator	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit mers (IC555). iode voltage regula r, switching regulato	ons, 6 ier, 8 iir, 8 iits, 9 ive 5 tor, 6 rs.
III IV V	Basic Trans biasir Tran Ampl comn ampli Oper Basic ideal ampli Op-a Volta feedb Regu Block series	ers and clamper es of Transistor istor structure, ing methods, transistor istorized Amp ifier fundament non collector a fier, frequency ational Amplif op-amp confi op-amp confi op-amp circu ifier, difference mp Application ge comparator, ack, types of os lated DC Powe c diagram of re- s and shunt regu	s; Zener diode, LEI types (BJT, FET a asistor as a switch, I blifiers: tals, small signal mplifier; JFET/MC response of amplifi ier guration, op-amp p it analysis, invert amplifier, unity gai ns: , Schmitt trigger c ccillator, RC oscilla er Supply: egulated dc power lator, op-amp based Tex	D, Photodiode and and MOSFET), tra Introduction to CM amplifiers: common DSFET common iers. powering, feedba- ing, non-invertin in buffer. fircuit, multivibra tors, monolithic ti supply, Zener d d voltage regulator	Solar Cell. ansistor configuration AOS circuit. non emitter amplif source/ common dr ck in op-amp circu g amplifier, summ tors, effect of posit mers (IC555).	ons, 6 ier, 8 iir, 8 iits, 9 ive 5 tor, 6 rs.

Course Contents for B. Tech. Programme, Department of Electronics Engineering, AY2023-24

2	Ramakant Gaikwad, "Op-amp and Linear Integrated Circuits", 4 th edition, Pearson, 2015.
3	Albert Malvino, David J. Bates, "Electronic Principles", 7 th Edition, McGraw Hill Education, 2017.
4	
	References
1	Donald A. Neamen, "Electronic Circuit Analysis and Design", 3 rd edition, Tata McGraw Hill, 2011
2	Robert F. Coughlin and Frederick F. Driscoll, "Operational Amplifiers and Linear Integrated Circuits", 6 th edition, PHI, 2009
3	Donald A. Neamen, "Microelectronics: Circuit Analysis and Design", 4th Edition, McGraw Hill Education (India) Private Limited, New Delhi, 2021.
4	
	Useful Links
1	https://nptel.ac.in/courses/108101091
2	https://nptel.ac.in/courses/108108112
3	https://nptel.ac.in/courses/122106025
4	https://nptel.ac.in/courses/117103063

CO-PO Mapping													
	Programme Outcomes (PO) PSO												
1	2	3	4	5	6	7	8	9	10	11	12	1	2
2	2												2
2	3												2
2	3												2
	3	3											2
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
	2 2	$ \begin{array}{c ccc} \hline 2 & 3 \\ \hline 2 & 3 \\ \hline & 3 \end{array} $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1 2 3 4 2 2 2 3 2 3 2 3 3 3	Progra 1 2 3 4 5 2 2 2 3	I 2 3 4 5 6 2 2	1 2 3 4 5 6 7 2 2	Programme Outcomes (PO 1 2 3 4 5 6 7 8 2 2	Image: Constraint of the state of	I 2 3 4 5 6 7 8 9 10 2 2	I 2 3 4 5 6 7 8 9 10 11 2 2	I 2 3 4 5 6 7 8 9 10 11 12 2 2	Programme Outcomes (PO) PS 1 2 3 4 5 6 7 8 9 10 11 12 1 2 2 .<

Each CO of the course must map to at least one PO.

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

				t Aided Autonoi AY 2023-24							
			Co	ourse Informa							
Program	ne			lectronics Eng							
Class, Sen			````	B. Tech. Sem	<u> </u>						
Course Co			7CH155								
Course Na				Engineering Chemistry Lab							
Desired R		c•	0	•		l higher seconda	ary laval				
	equisite	3.	Chemistry	course at secon		i inglier secolida					
Tea	ching So	heme		Exan	nination	Scheme (Mark	s)				
		2Hrs/									
Pract	ical	Week	LA1	LA2	Lab ESE		Total				
	0Hrs/		30								
Intera	Interaction Week			30	4	0	100				
		W CCK			Cro	edits: 1					
					Cit	u1130 I					
			ſ	ourse Object	ives						
1	To mal	ce the studer		h analytical te							
2				Instrumental a							
						conomy Level					
At the end	of the c	ourse, the st	udents will be	able to,							
						Bloom's	Bloom's				
CO		Course	Outcome St	atement/s		Taxonomy	Taxonomy				
	Apply	principlos	of Volur	netry/gravime	tray to	Level	Description				
CO1	Apply			r quality par		III	Applying				
COI		and alloys.		i quality pai	unieter,		rippiying				
CO3		~	of instrument for quantitative III				A				
CO2	analysi	.s.		-		111	Applying				
CO3	Experi	· ·		characterist	ics of	III	Applying				
	materia	al. Execute p	reparation of	product.							
	T •	4 6 5 •		0.	4 6	41 6 11 •	1. ()				
		st of Experi		-		om the followin	<u> </u>				
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2				water (Neutra	lization 7	Titration).					
				xygen in wate							
3	r	Fitration).									
4				ntent in water			2 Hrs. each				
5			-	r & pH metric			Expt.				
6			-	of acid/base by	y conduct	tometrically.	Ĩ				
7 8			estimation of		motria	itration)					
8				Bronze. (Iodo ss (Displacem							
10											
			<u> </u>	Iron (Redox 7 of given liqui							
11		viscometer.		6 ····· ··· ··· ···							
				n rate by weigh							
12		Gravimetric	estimation of	Ba from BaSC	D_4 as BaO).					
13											
		Preparation of	of Resin	Topics(Appli							

							Te	xtbo	oks						
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								ferer							
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2			is", Vog									mas, Ç			Chemica
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	1	2	3	4	5	6	7	8	9	10	11	12	1		2
CO1	3														
CO2	3														
CO3	3														
The strengt	h of n	nappi	ng is to	be w	vritte	n as 1	,2,3;	wher	e, 1:	Low, 2	2: Mediu	m, 3: Hi	gh		
Each CO o	f the c	ourse	e must n	nap t	o at l	east o	one P	O, an	d pr	eferabl	y to only	one PO			
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There are the the there are the the the the the the the the the th												1	100/		
IMP: Lab E Assessm			barate ne Based o				(min) ted by),LA		2 should ical Sche		40% 		Jarks
A55C55111	ent		Lab			luuc		y		турі					
		a	ctivities	s	L	ab Co	ourse			•	k 1 to We				
LA1			tendanc			Facu					nission at	the end	of		30
			journal				•		Veek	8					
			Lab					E	Durin	g Weel	k 9 to We	eek 16			
LA2		a	ctivities	s,	La	ab Co	ourse	N	Aark	s Subm	nission at	the end	of		30
			tendanc	.		Facu	lty	V	Veek	16					50
			journal												
			Lab		Ŧ	1 0			Durin	g Weel	k 18 to V	Veek 19			
Lab ES	Е		ctivities			ab Co				-		the end	of		40
		1	journal/ rformar			Facu	ity	V	Veek	19					
Week 1 ind	iootor	-			0.007	actor	·Iat		ritio	/Lob a	orforma	han chall	inclus	la narí	omina
	IL ALES	statt	mg wee	LO V	a 5011	rester	. Lau	acus	11105	Lau p	Unormal	ice shall	menue		
experiment						ireme	ent of	the la				rimental	lab sh	all ha	ve

		Wa	alchand Colleg (Government Ai	ded Autonomous Ins		ngn			
			A	Y 2023-24					
			Cours	se Information					
Progra	amme		B. Tech. (Electron	nics Engineering)					
Class,	Semest	er	First Year B. Tech	n., SemI					
Cours	e Code		7ME108						
Cours	e Name	•	Engineering Grap	hics					
Desire	d Requ	isites:	Basic Knowledge	of Computer					
Т	eaching	Scheme		Examination	Scheme	(Marks)			
Practi	ractical 2Hrs/Week LA1 LA2 ESE Tot								
Intera	ction	1 Hrs/Week	30	30		40	100		
				Cre	edits: 2	I			
			1						
			Cour	rse Objectives					
1	To im	part the technic	ues of engineering	0					
2		•	nts for applying kno	<u> </u>	ring grap	hics in real li	fe drawings.		
3	To dev	velop the skills	of students for eval	uating CAD softw	are for its	s applications			
			0			T 1			
A 4 41			rse Outcomes (CO)	,	axonomy	Level			
At the		ine course, the	students will be able			Bloom's	Bloom's		
co	Cours	e Outcome St	atement/s			Taxonomy	Taxonomy		
00	Court					Level	Description		
CO1	Under	stand the basic	principle of Engine	ering graphics.		II	Understanding		
CO2			of components usin	ng the first angle		III	Applying		
	1 2	tions method.							
CO3	Apply applic	Ų	e of engineering gra	phics in real life		III	Applying		
			List of Export	iments / Lab Acti	vitios		1		
List of	Fynor	iments:		ments / Lab Acti	vittes				
			ollowing topics (A	ny two sheets on (CAD)				
			ections (Min. 5 Prot		(112)				
			Lines (Min. 5 Proble						
5			Solids (Min. 6 Probl	,					
			urfaces (Min. 3 Prob	olems)					
		ic Projections (rojections (Min	Min. 2 Problems)						
5. 18011		Tojections (Min	i. 2 Floblellis)						
			Т	ext Books					
1	Bhatt	N.D., Panchal	V.M. and Ingle P.R.		wing, Ch	arotar Publisł	ning House, 2014		
2			a B.C., Engineerin						
3		val B. and Agra	awal C. M., Enginee	ering Graphics, TM	/IH Public	cation, 2012.			
				Dofomon					
1	Naray	ana KI and I	Kannaiah, Text bo	References	Drawin	Scitach Dul	lishers 2008		
2			Fundamentals of E						
3	Fredd		ccke, Alva Mitchel	l others, Principl	les of Er	igineering Gi	aphics, Maxwel		
	McMi	llan Publishing	, 2010						
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1	https:/	/nptel.ac.in/cou	Us urses/112/103/11210	seful Links 03019/					

2	https://nptel.ac.in/courses/105/104/105104148/
	https://www.youtube.com/watch?v=xXdpkQXDuMw&list=PL9RcWoqXmzaJT-fliqTSwUjWU4zCX_H2A

	CO-PO Mapping For Electrical Engineering Department														
		Programme Outcomes (PO) PSO													
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	
C01	2				1					1		1			
CO2			1												
CO3					2					1					
The stren	The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High														

	CO-PO Mapping Electronics Engineering Department															
		Programme Outcomes (PO)											PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2		
CO1	1				1					1						
CO2			1													
CO3					2					1						
The stren	gth of 1	mappii	ng is to	be wri	itten as	1.2.3:	Where	e, 1:Lo	w, 2:N	ledium	n, 3:Hi	gh				

CO-PO Mapping Computer Science and Engineering Department Programme Outcomes (PO) PSO **CO1 CO2 CO3**

The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High

	CO-PO Mapping For Information Technology Department														
		Programme Outcomes (PO)											PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	
CO1					3					1		1			
CO2			1												
CO3					3					1					
The stren	The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High														

The stiength of mapping is to be written as 1,2,3, where, 1.20w, 2.wedium, 3.mgn

Assessment													
	There are three components of lab assessment, LA1, LA2 and Lab ESE. IMP: Lab ESE is a separate head of passing.(min 40 %), LA1+LA2 should be min 40%												
Assessmen	Based on	Conducted by	Typical Schedule	Mark									
t				s									
LA1	Lab activities,	Lab Course	During Week 1 to Week 8	30									
	attendance, journal	Faculty	Marks Submission at the end of Week 8	50									
LA2	Lab activities,	Lab Course	During Week 9 to Week 16	30									
	attendance, journal	Faculty	Marks Submission at the end of Week 16	50									
		Lab Course											
	Lab activities,	Faculty and	During Week 18 to Week 10										
Lab ESE	journal/	External	During Week 18 to Week 19 Marks Submission at the end of Week 19	40									
	performance	Examiner as	Marks Submission at the end of week 19										
		applicable											

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and

related activities if any.

	Wal		e of Engineerin ed Autonomous Instit		gli						
		AY	2023-24								
		Course	e Information								
Programme		B.Tech. (Electron	ics Engineering)								
Class Semeste	r	First Year B. Tech	h Semester-I								
Course Code 7CS107											
Course Name		Computer Program	mming (C Program	ming)							
Desired Requis	ites:	-									
				a a a							
Teaching			Examination	· ·							
Practical	2 Hrs/ Week	LA1	LA2	Lab I		Total					
Interaction	2 Hrs/ Week	30	30	40		100					
			Cre	dits: 3							
		Cours	e Objectives								
	A	olving and problen	<u> </u>								
		and future of C pro	0 0								
•			statements, decis	ion makin	ig, looping, f	unctions, array,					
string, p	ointer, structure		with Bloom's Tax	onomy I d	avol						
At the end of the		lents will be able to									
СО		rse Outcome State	·		Bloom's Taxonomy Level	Bloom's Taxonomy Description					
CO1 To un program	derstand the nming.	basics of pro	blem solving	and C	II	Understand					
		hms to programs			III	Applying					
CO3 To test errors.	and execute the	C programs and	correct syntax and	l logical	IV	Analyse					
· ·	T	ist of Experiment	ts / Lab Activities/	Tonics							

List of Topics (Applicable for Interaction Mode):

Module I: Basics of Problem Solving & C Programming: General Problem Solving Concepts, Types of Problems, Problem Solving Strategies. **Program Design Tools:** Algorithms, Flowcharts and Pseudo-Codes. **C Programming:** Types of programming languages, Features of C, Basic Concepts, Structure of a C Program, Declarations, Constants, Variables, Data Types, Operators and Expressions, Input and Output Functions.

Module II: Decision Control Statements: Conditional Statements: If, If-else, Nested If, If-elseif Statements. **Iterative Statements:** While Loop, For Loop, Do While Loop, Break, Continue, Pass, else Statement used with Loops.

Module III: Functions: Need for functions, Definition, Function Call, Block Structure, Variable Scope, Return Type, Passing Arguments to a Function: Call by Reference, Call by Value, Recursive Functions.

Module IV: Array: Declaration, Initialization, Two-Dimensional Arrays, Multi-Dimensional Array. **String**: Declaration and Initialization of Strings, Array of Strings, String functions.

Module V: Pointers: Introduction, Definition and Declaration of Pointers, Address Operator, Pointer Variables. **Structures and Unions:** Declaration, Initialization, Accessing members of a Structure, Initializing a Union, Accessing the Members of a Union.

Module VI: File handling: Concept of a File, Types of File, File Operation, File functions, File opening modes in C, Reading, Write and Closing a File.

List of Experiments:

- 1. Program to simulate simple calculator that performs basic tasks such as addition, subtraction, multiplication and division.
- 2. Program to demonstrate different operators and their order precedence.
- 3. Program to accept the number and Compute a) square root of number, b) Square of number, c) Cube of number d) check for prime, d) factorial of number e) prime factors.
- 4. Program to accept a number from user and print digits of number in a reverse order.
- 5. Program to accept two numbers from user and compute smallest divisor and Greatest Common Divisor of these two numbers.
- 6. Program to find whether the number is positive / negative / zero using conditional statement.
- 7. Programs to show different types of iteration / loop.
- 8. Program to accept N numbers from user and compute and display maximum in list, minimum in list, sum and average of numbers.
- 9. Program to print the Fibonacci Series (with & without recursion).
- 10. Program to swap two number using function (Call by value & reference).
- 11. Program to demonstrate structure to array.
- 12. Program to demonstrate structure and union.
- 13. Program to demonstrate file handling.

	Textbooks
1	E. Balaguruswamy, Programming in ANSI C, Tata McGraw-Hill.
2	Yashavant Kanetkar, "Lets Us C", BPB Publication, 5th Edition, 20216.
	References
1	Maureen Spankle, "Problem Solving and Programming Concepts", Pearson; 9 th edition, ISBN-10:
1	9780132492645, ISBN-13: 978-0132492645.
2	Herbert Schidt, C: The complete reference, 4th edition, McGraw Hill publication.
3	Brian W. Kernighan and Dennis M. Ritchie, The C Programming Language, Prentice
5	Hall of India
	Useful Links
1	https://www.programiz.com/c-programming
2	https://www.w3schools.com/c/c_intro.php
3	https://www.javatpoint.com/c-programming-language-tutorial

	CO-PO Mapping													
		Programme Outcomes (PO)PSO												
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3	2												
CO2	1		2		2									
CO3		2	1	2										
The stre	ngth of	mappi	ng is to	be wri	tten as	1,2,3; v	where, 1	l: Low,	2: Mec	lium, 3	High			

Each CO of the course must map to at least one PO, and preferably to only one PO.

		Assessment		
	*	b assessment, LA1, LA2 an of passing.(min 40 %), LA	ld Lab ESE. 1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
	Lab activities,		During Week 1 to Week 8	
LA1	attendance,	Lab Course Faculty	Marks Submission at the end of	30
	Submission		Week 8	
	Lab activities,		During Week 9 to Week 16	
LA2	attendance,	Lab Course Faculty	Marks Submission at the end of	30
	Submission		Week 16	

Course Contents for B. Tech Programme First Year, AY 2023-24

	Lab activities/	Lab Course Faculty and	During Week 18 to Week 19	
Lab ESE	submission/	External Examiner as	Marks Submission at the end of	40
	performance	applicable	Week 19	
Week 1 indicate	es starting week o	f a semester. Lab activities/	Lab performance shall include perfor	rming
experiments m	ini-project prese	ntations drawings program	ming and other suitable activities as	s ner the

experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

Walchand College of Engineering, Sangli

(Government Aided Autonomous Institute)

	AY 2023-24
	Course Information
Programme	First Year B. Tech. (Electronics Branch)
Class, Semester	First Year B. Tech., Sem I
Course Code	7EL156
Course Name	Basic Electrical Engineering Lab
Desired Requisites:	NIL

Teachin	g Scheme		Examinatio	on Scheme (Marks)	
Practical	2 Hrs/ Week	LA1	LA2	Lab ESE	Total
Interaction		30	30	40	100
			C	Credits: 1	

Course	Ohi	inctives
Course	U U	ecuves

This course intends to demonstrate basic knowledge of Electrical engineering.
 It intends to develop skills to recognize working principle, construction and types of electrical Machines.

Course Outcomes (CO) with Bloom's Taxonomy Level

At the end of the course, the students will be able to,

со	Course Outcome Statement/s	Bloom's Taxonomy Level	Bloom's Taxonomy Description
CO1	Describe basic concepts of electrical circuits and various theorems.	II	Understanding
CO2	Demonstrate the use of transformers and AC/DC machines.	III	Applying

List of Experiments / Lab Activities/Topics

List of Topics(Applicable for Interaction mode):

- 1. To study AC and DC machines parts and their functions.
- 2. Study of AC/DC motor starters.
- 3. To study servo motor/ steeper motor with application.
- 4. Study of installation techniques using fuse, MCB and MCCB.

List of Lab Activities:

- 1. Electrical Safety Measures.
- 2. To study series-parallel RL, RC and RLC circuits
- 3. To verify KVL and KCL theorems.
- 4. To study speed control techniques of dc motor.
- 5. To study speed control techniques of induction motor.
- 6. To perform load test on transformer.
- 7. Find out equivalent resistance in series and parallel connection.
- 8. Measure voltage, current and power in single phase R-C series circuit.
- 9. Measure Voltage, current and power factor of 1-phase A.C R-L series circuit.

	Textbooks
1	D.C. Kulshreshtha, "Basic Electrical Engineering", 1 st revised editionMcGraw Hill, 2012.
2	D.P Kothari and I.J Nagrath, "Basic Electrical Engineering", Tata McGraw Hill, 2010.
	D.C
	References
1	V. N. Mittle and Arvind Mittal, "Basic Electrical Engineering", 2 nd edition, Tata McGraw Hill.
	Useful Links
1	Virtual Labs ,An Initiative of Ministry of Education Under the National Mission on Education through ICT,
	1. https://www.vlab.co.in/broad-area-electrical-engineering

Proposed Course Contents for B. Tech. Programme, Department of Electrical Engineering, AY 2023-24

						CO-P	O Map	ping						
]	Progra	mme C)utcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													
CO2	3								2				-	

		Assessment		
		ab assessment, LA1, LA2 and of passing.(min 40 %), LA	nd Lab ESE. 1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30 •
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

			A	Y 2023-24			
				e Information			
Progra	amme			onics Engineering)		
	Semester		First Year B. Te	• •	,		
	e Code		7EN151				
	e Name		Analog Electron	nics Laboratory			
	d Requisi	ites:	12 th Physics				
2 0011 0	<u></u>		12 1 11 51 65				
]	Feaching	Scheme		Examination	n Scheme (Marks)		
Practi		2 Hrs/ Week	LA1	LA2	Lab ESE		Total
Intera		-	30	30	40		100
					redits: 1		100
			Cour	se Objectives			
	To prov	ide knowledge		•	its to first year eng	ineering	students s
1				ement simple elec		,1110011112	5 students, s
2					and amplifiers (vol	tage and	l current)
		T, FET and MC					
3	To illust	rate the method	is used for analys	is and design of o	p-amp based circuit	s.	
4		<u> </u>		·1 D1 1 T	T 1		
At the	and of the		dents will be able	with Bloom's Ta	ixonomy Level		
CO1				omponents and ins	struments		Understan
$\frac{CO1}{CO2}$					-amp based amplifi	iers.	Understan
CO3	-	<u> </u>	stor and op-amp b	·	ump oused umpm	1015.	Apply
CO4			A	using op-amp and	I IC555.		Apply
		L	ist of Experimer	nts / Lab Activitie	s/Topics		
List of	Topics(A	Applicable for I	nteraction mode	e):			
List of	Lab Acti	vities: (minim	um 08 experimer	nts)			
List of 1.	Lab Acti Study of	vities: (minim p-n junction di	um 08 experimer ode characteristic	nts) s.			
List of 1. 2.	Lab Acti Study of Analyze	vities: (minim p-n junction di the performanc	um 08 experimer ode characteristic re diode rectifier c	its) s. vircuits			
List of 1. 2. 3.	Lab Acti Study of Analyze Study of	vities: (minim p-n junction di the performanc diode based cli	um 08 experimer ode characteristic e diode rectifier c pper and clamper	nts) s. vircuits • circuits	nd MOSFET).		
List of 1. 2.	Lab Acti Study of Analyze Study of Study of	vities: (minimo p-n junction di the performanc diode based cli transistor as a	um 08 experimer ode characteristic e diode rectifier c pper and clamper	nts) s. circuits circuits ier (BJT, JFET, ar	nd MOSFET).		
List of 1. 2. 3. 4. 5. 6.	Lab Acti Study of Analyze Study of Study of Study of Study of	vities: (minim p-n junction di the performanc diode based cli transistor as a common emitte common collect	um 08 experiment ode characteristic per diode rectifier c pper and clamper switch and amplif er/common source ctor/common drai	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier.			
List of 1. 2. 3. 4. 5. 6. 7.	Lab Acti Study of Analyze Study of Study of Study of Study of Study of	yities: (minimu p-n junction di the performance diode based cli transistor as a common emitte common collect inverting and r	um 08 experiment ode characteristic the diode rectifier of pper and clamper switch and amplif er/common source ctor/common drait ton-inverting amp	nts) s. circuits circuits ier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am	р.		
List of 1. 2. 3. 4. 5. 6. 7. 8.	Lab Acti Study of Analyze Study of Study of Study of Study of Impleme	vities: (minimu p-n junction di the performance diode based cli transistor as a common emitte common collect inverting and re-	um 08 experimer ode characteristic e diode rectifier c pper and clamper switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subti	p. ·actor).	ing on (
List of 1. 2. 3. 4. 5. 6. 7. 8. 9.	Lab Acti Study of Analyze Study of Study of Study of Study of Study of Impleme Analyze	wities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance	um 08 experiment ode characteristic re diode rectifier of pper and clamper switch and amplif er/common source ctor/common drait ion-inverting amp mp based application re of waveform get	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subti-	р.	ing op-a	amp.
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10	Lab Acti Study of Analyze Study of Study of Study of Study of Impleme Analyze Build an	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and n entation of op-an the performance d test multivibr	um 08 experiment ode characteristic per diode rectifier of pper and clamper switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat er of waveform ge ator/ timer circuit	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtu enerators (multivib s using IC 555.	p. actor). rator/ oscillator) us		-
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10	Lab Acti Study of Analyze Study of Study of Study of Study of Impleme Analyze Build an	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance d test multivibr regulated dc po	um 08 experiment ode characteristic per diode rectifier of pper and clamper switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat er of waveform ge ator/ timer circuit	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtu enerators (multivib s using IC 555.	p. ·actor).		-
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10	Lab Acti Study of Analyze Study of Study of Study of Study of Impleme Analyze Build an Study of	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance d test multivibr regulated dc po	um 08 experiment ode characteristic per diode rectifier of pper and clamper switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat er of waveform ge ator/ timer circuit	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtu enerators (multivib s using IC 555.	p. actor). rator/ oscillator) us		-
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10	Lab Acti Study of Analyze Study of Study of Study of Study of Study of Impleme Analyze Build an Study of regulato	vities: (minim ⁷ p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per and clamper switch and amplif er/common source ctor/common drai ion-inverting amp mp based applicat be of waveform ge ator/ timer circuit ower supply (Zene	nts) s. circuits circuits fer (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re	p. actor). rator/ oscillator) us gulator/ op-amp ba	sed line	ar voltage
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11	Lab Acti Study of Analyze Study of Study of Study of Study of Study of Impleme Analyze Build an Study of regulato	wities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per and clamper switch and amplif er/common source ctor/common drai ion-inverting amp mp based applicat be of waveform ge ator/ timer circuit ower supply (Zene	nts) s. circuits circuits fer (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re	p. actor). rator/ oscillator) us	sed line	ar voltage
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11	Lab Acti Study of Analyze Study of Study of Study of Study of Study of Impleme Analyze Build an Study of regulato	wities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-an the performance d test multivibr regulated dc por r).	um 08 experimen ode characteristic re diode rectifier of pper and clamper switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zene Touis Nashelsky,	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. difier using op-am tions (adder / subtractions) (adder / subtractions) s using IC 555. er diode voltage re <u>fextbooks</u> 11 th edition, "Ele	p. actor). arator/ oscillator) us gulator/ op-amp ba ctronic Devices an	nd Circu	ar voltage nits, Pearson
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11	Lab ActiStudy ofAnalyzeStudy ofStudy ofStudy ofStudy ofStudy ofBuild anStudy ofregulatorRobe2015Rama	vities: (minim ⁷ p-n junction di the performance diode based cli transistor as a s common emitte common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per diode rectifier of switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zend T ouis Nashelsky, "Op-amp and Lin	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re <u>Sextbooks</u> 11 th edition, "Ele	p. cactor). rator/ oscillator) us gulator/ op-amp ba ctronic Devices an rcuits", 4 th edition, 1	nd Circu Pearson,	ar voltage nits, Pearson , 2015.
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11	Lab Acti Study of Analyze Study of Build an Study of regulator Robe 2015 Rama Albe	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per diode rectifier of switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zend T ouis Nashelsky, "Op-amp and Lin	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re <u>Sextbooks</u> 11 th edition, "Ele	p. actor). arator/ oscillator) us gulator/ op-amp ba ctronic Devices an	nd Circu Pearson,	ar voltage nits, Pearsor , 2015.
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11 2 3	Lab ActiStudy ofAnalyzeStudy ofStudy ofStudy ofStudy ofStudy ofBuild anStudy ofregulatorRobe2015Rama	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per diode rectifier of switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zend T ouis Nashelsky, "Op-amp and Lin	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re <u>Sextbooks</u> 11 th edition, "Ele	p. cactor). rator/ oscillator) us gulator/ op-amp ba ctronic Devices an rcuits", 4 th edition, 1	nd Circu Pearson,	ar voltage nits, Pearsor , 2015.
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11 2	Lab Acti Study of Analyze Study of Build an Study of regulator Robe 2015 Rama Albe	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experiment ode characteristic per diode rectifier of switch and amplif er/common source ctor/common drai non-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zend T ouis Nashelsky, "Op-amp and Lin	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re <u>Sextbooks</u> 11 th edition, "Ele	p. cactor). rator/ oscillator) us gulator/ op-amp ba ctronic Devices an rcuits", 4 th edition, 1	nd Circu Pearson,	ar voltage nits, Pearsor , 2015.
List of 1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11 2 3	Lab Acti Study of Analyze Study of Build an Study of regulator Robe 2015 Rama Albe	vities: (minimu p-n junction di the performance diode based cli transistor as a s common emitte common collect common collect inverting and r entation of op-ar the performance d test multivibr regulated dc por r).	um 08 experimen ode characteristic per and clamper switch and amplif er/common source ctor/common drai ion-inverting amp mp based applicat e of waveform ge ator/ timer circuit ower supply (Zene T couis Nashelsky, "Op-amp and Lin vid J. Bates, "Elec	nts) s. circuits circuits fier (BJT, JFET, ar e amplifier. n amplifier. lifier using op-am tions (adder / subtr enerators (multivib s using IC 555. er diode voltage re <u>Sextbooks</u> 11 th edition, "Ele	p. cactor). rator/ oscillator) us gulator/ op-amp ba ctronic Devices an rcuits", 4 th edition, 1	nd Circu Pearson,	ar voltage nits, Pearson , 2015.

2	Robert F. Coughlin and Frederick F. Driscoll, "Operational Amplifiers and Linear Integrated Circuits", 6 th edition, PHI, 2009
3	Donald A. Neamen, "Microelectronics: Circuit Analysis and Design", 4th Edition, McGraw Hill Education (India) Private Limited, New Delhi, 2021.
4	
	Useful Links
1	https://nptel.ac.in/courses/122106025
2	https://nptel.ac.in/courses/108101091
3	https://nptel.ac.in/courses/108105113
4	

	CO-PO Mapping												
		Programme Outcomes (PO) PSO											
	1	2 3 4 5 6 7 8 9 10 11 12 1 2											
CO1	2	2											
CO2	2	2 2 2											
CO3				2					1				3
CO4				2					1				3
The stre	The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High												
Each CO) of the	e course	e must 1	nap to	at least	one PC), and p	referab	ly to or	nly one	PO.		

		Asses	sment	
There are three	components of la	b assessment, LA1,	LA2 and Lab ESE.	
IMP: Lab ESE	is a separate head	of passing.(min 40	%), LA1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

		Wa	Ichand Colleg	ge of Enginee		ngli	
				Y 2023-24			
				se Information			
Progra	mme			onics Engineering	g)		
	Semester		First Year B. Te	<u> </u>	D/		
Course			7VS152				
	e Name		Engineering Ski	11s-II			
	d Requis	ites:	-				
	1						
Т	eaching	Scheme		Examination	on Scheme	(Marks)	
Practic	<u> </u>	2 Hrs/ Week	LA1	LA2	Lab E		Total
Interac	ction	-	30	30	40		100
				(Credits: 1	I	
		1	1				
			Cou	rse Objectives			
1	To provi	de basic know	ledge of handling	electrical equipn	nent and saf	ety.	
2	To impa	rt skills to plan	and implement si	imple electrical v	viring.	-	
3			o the students with		ence on var	ious basic eng	ineering
			and Electronics En		atuar !- 1 11	1	
4	10 expla		g of small electron are Outcomes (CO				ump etc.
At the	end of the		udents will be able	/			
CO		Outcome Stat				Bloom's Taxonomy Level	Bloom's Taxonomy Description
CO1	v		ts for measuremen	1		Ι	Remembering
CO2	protectio	ons.	of switchgear f		afety and	III	Applying
CO3	· ·	A	he use of electroni			II	Understanding
CO4	Build ar	nd Test simple	electronic gadget	•		III	Applying
				nta / Tab Astiri	ioa/Tonioa		
	ering Sk		List of Experime num 08 experime		nes/1opics		
i. ii. Modul i.	Mea e 2: Stuc	surement of E	lectrical Parameter lectrical Parameter opes of wires and c	rs in Single Phase cables.	e AC Circui	ts.	
ii. iii. Modul	Den	÷	nes for residential peration of fuse, N	•	plications.		
i. ii.	Prep Disr	nantling, Asse	thing Pit for Electr mbly and Fault Fin Vater Heater, Use o	nding of Ceiling	•	e Fans, Autom	atic Electric
Modul	e 1: Intro		cs) 5 Instruments like measurement usi			lator, Multi m	eter. Frequency
		• •	nents (Resistance ead identification	e, capacitor, Die	ode, Transi	stor, Transfo	rmer, switches,
Modul							

	Textbooks
1	Make: Electronics, by Charles Platt, Published by Maker Media, 2015
2	Electronics Projects For Dummies, by by Earl Boysen and Nancy Muir, Published by Wiley
	Publishing, Inc., 2006
3	D.C. Kulshreshtha, "Basic Electrical Engineering", 1 st revised editionMcGraw Hill, 2012.
4	D.P Kothari and I.J Nagrath, "Basic Electrical Engineering", Tata McGraw Hill, 2010.
	References
1	Paul Horowitz, Winfield Hill, "The Art of Electronics", Cambridge University Press, 1989
2	E-learning material through Intranet/Internet
3	V. N. Mittle and Arvind Mittal, "Basic Electrical Engineering", 2 nd edition, Tata McGraw
5	Hill.
4	
	Useful Links
1	
2	
3	
4	

	CO-PO Mapping												
		Programme Outcomes (PO) PSO											
	1	2 3 4 5 6 7 8 9 10 11 12 1 2											
CO1													
CO2													
CO3				2					1				1
CO4				2					1				2
The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High													
Each CO	O of the	e course	e must i	map to	at least	one PC), and p	referab	ly to or	nly one	PO.		

	*		LA2 and Lab ESE. %), LA1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

			AY 2	2023-24					
			Course I	nformation					
Progra	amme		B. Tech. (Electron	nics Engineering)					
Class,	Semester		First Year B. Tecl	n., SemII					
Cours	e Code		7MA103						
Cours	e Name		Engineering Math	ematics-II					
Desire	d Requis	tes:	Mathematics cour	se at Higher Secon	ndary Junior Colleg	e			
1	Teaching	Scheme		Examination S	cheme (Marks)				
Lectur	0	3 Hrs/week	MSE	ISE	ESE	Total			
Futori		1 Hrs/week	30	20	50	100			
					its: 04				
		1	<u> </u>						
			Course	Objectives					
1	Familiar	ze the students		•	ration and Differen	tial equation.			
2					and analyse the En				
3	problem								
4									
			Outcomes (CO) wi		nomy Level				
	end of the	course, the stud	ents will be able to	,		1			
CO1	Understand the Mathematical Tools that are needed to solve Engineering $ _{\rm Under}$								
	problem	problem							
CO2	Solve th	e problems in mu	ultivariable calculus	S,		Applying			
CO3	Apply th	e statistical tech	inique to interpret t	he data		Applying			
CO4									
						1			
Modu			Module Co	ontents		Hours			
Ι			ions: Gamma functions	6					
II		ve tracing ing of curves for	Cartesian and pola	r coordinate		6			
III	Multivariable Calculus: Multiple Integrals: Double integrals, change of order of integration, change								
IV	Line Line funct	ear Differential ar Differential ion, Particular Ir	0	nstant coefficient		8			
V	function, Particular Integral Applications of L.D.E with constant Coefficient: Applications of L.D.E with constant Coefficient to Electrical Engineering 4								
						_			

	Correlation, Linear regression, Curve fitting (a) straight line (b) logarithmic	7
	curve,	
	Textbooks	
1	P. N. and J. N. Wartikar, "A Text Book of Applied Mathematics", Vol I and Griha Prakashan, Pune, 2006	nd II", Vidyarthi
2	B.S. Grewal, "Higher Engineering Mathematics", Khanna Publication, 44th	Edition , 2017.
3	S.C. Gupta, "Fundamentals of Mathematical Statistics and probability" &Sons,2014.	", Sultan chand
4		
	References	
1	Erwin Kreyszig, "Advanced Engineering Mathematics", Wiley Eastern Line 2015, 10 th Edition	nited Publication,
2	Wylie C.R, "Advanced Engineering Mathematics", Tata McGraw Hill Edition, 1999	Publication, 8th
3	H. K. Dass, "Higher Engineering Mathematics", S. Chand & Company Ltd.,	1 st Edition 2014.
4	S. S. Sastry, "Engineering Mathematics (Volume-I)", Prentice Hall Publica 2006	tion, 3rd Edition
	Useful Links	
1	https://www.youtube.com/watch?v=KgItZSst2sU	
2	https://nptel.ac.in/courses/111105121	
3		
4		

	CO-PO Mapping												
		Programme Outcomes (PO) PSO											
	1	2 3 4 5 6 7 8 9 10 11 12 1 2											
CO1	2	2 1 1											
CO2	2	2 1 1											
CO3	2			1									
CO4													
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	of the c	course 1	nust m	ap to at	t least c	one PO.							

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

	W	alchand Col	lege of Engineer	ring, Sa	ngli			
			t Aided Autonomous In		C			
			AY 2023-24					
		Co	ourse Information					
Programm	e	B.Tech. (Electr	onics Engineering)					
Class, Sem	ester	First Year B. To	ech., SemII					
Course Co	de	7PH102						
Course Na	me	Engineering Ph	ysics					
Desired Re	quisites:	Students are ex	pected to know the ba	asic conce	ept in Phy	vsics.		
Teach	ing Scheme		Examination	Scheme	(Marks)			
Lecture	03Hrs/week	MSE	ISE	ESE	E	Total		
Tutorial	0 Hrs/week	30	20	50		100		
			Cr	edits: 3				
	·							
		С	ourse Objectives					
1	To provide bas	sic concepts to so	lve many engineerin	g and tecl	nnical iss	ues.		
2	To give deep i	nsights into the u	inderstanding of engi	neering co	ourses.			
3			nd engineering and te		-	ent.		
			CO) with Bloom's T	axonomy	Level			
At the end of	of the course, the	students will be a	ble to,					
СО		Course Outcom	e Statement/s		Bloom's Taxono my Level	Bloom's Taxonomy Descriptor		
C01		ns, basic concepts d Quantum rs, Instrument	· · · · · · · · · · · · · · · · · · ·	-	1	Remembering		
CO2		U U	facts and ideas by rec terms in these module	0	2	Understanding		
CO3	-	cts, techniques ar	ns by applying acquin nd rules for	red various	3	Applying		
Module		Mod	ule Contents	·		Hours		
I	Fresnel's diff diffraction at	Wave optics: Introduction, interference of light, Newton's rings, Fresnel's diffraction: Fresnel's half-period zones, zone plate and diffraction at a straight edge. Fraunhofer's diffraction: Diffraction due to single slit, Diffraction due to double slits, Plane diffraction grating.						

			1		
	II	Modern Physics and Quantum mechanics: Introduction, black body radiation, Planck's quantum theory, Wien's displacement law and Rayleigh – Jeans law, phase velocity, group velocity and particle velocity, de-Broglie's hypothesis, Photoelectric effect, Compton	0		
	11	effect, Heisenberg's uncertainty principle and applications, wave function and physical significance, Schrödinger's wave equation: time dependent and time independent, Eigen value and Eigen function.	8		
		Ultrasonic: Introduction, generation of ultrasonic waves			
	III	(Magnetostriction and Piezoelectric method), detection of ultrasonic waves by Kundt's tube, thermal detection and sensitive flame method,	C C		
	111	velocity of ultrasonic waves in liquid, applications of ultrasonic	6		
		waves in scientific and engineering field.Semiconductors:Introduction, formation of energy bands,			
	IV	classification of solid on basis of band theory, number levels in a band, density of states, Fermi-Dirac statistics, Fermi level, variation of Fermi level with temperature, electrical conductivity of metal and	7		
		semiconductor, Hall effect, basic concept of p-n junction.			
		Instrumentation and Transducers: Introduction, instrumentations,			
	V	measurement system, control system, Transducer and Sensor: transducers, sensors, classification of transducers, characteristics of			
	•	transducers, selection criterion for transducers, temperature	6		
		transducers, strain gauge, pressure transducers, force transducers,			
		optical transducers and actuators.			
		Microchip Design: Introduction, Crystal growth, Epitaxial diffusion			
	VI	process, types of integrated circuit, Development of integrated components (diode, transistor, resistor and capacitor), Implementation	6		
		in integrated circuit.			
		Textbooks		<u> </u>	
	1	M. N. Avadhanulu and P. G. Kshirsagar, "A Text book of Engineerir Pub.		.Chand	
	2	R. K. Gaur and S. L. Gupta "Engineering Physics", Dhanpat Rai Public	ations, 2011		
		References			
	1	Halliday, Resnic and Walker, "Fundamentals of Physics", John Wiley,	9th edition 201	1.	
	2	A. Beiser, "Concepts of Modern Physics", McGraw Hill International,			
	3	Ajoy Ghatak, "Optics", Tata McGraw Hill 5th edition, 2012.	,		
	4	Halit Eren, John G. Webster "Measurement, Instrumentation, and Sens Press 2018	sors Handbook	" CRC	
	5	Yaguang Lian "Semiconductor Microchips and Fabrication: A Pract and Manufacturing" Wiley 2022	ical Guide to	Theory	
		Useful Links			
	1	For optics <u>https://nptel.ac.in/courses/122/107/122107035/</u>	. /		
	2	For Quantum Physics <u>https://nptel.ac.in/courses/122/106/122106034</u>			
	3	For Ultrasonic <u>https://freevideolectures.com/course/3531/engineerin</u>			
	4	For Solid State Physics <u>https://nptel.ac.in/courses/115/105/11510509</u>	99/		
	5	For Instrumentation and Transducers <u>https://youtu.be/1uPTyjxZzyo</u>			
	6	For Microchip Design <u>https://youtu.be/HdcLRMv3D3g</u>			
-		CO-PO Mapping		Daa	
L		Programme Outcomes (PO)		PSO	
L		1 2 3 4 5 6 7 8 9 10	11 12	1	

12345678910111212Course Contents for F.Y.B.Tech Engineering Physics for Electrical & Electronics Engineers AY2023-24

CO1	2											
CO2	2											
CO3	2											
The strength of	of ma	pping i	s to be	writter	as 1: I	Low, 2:	Mediu	m, 3: H	ligh			
Each CO of th	ne con	urse mu	ıst map	to at le	east one	e PO.						
						Asses	sment					

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

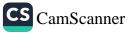
ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be Tests, assignments, oral, seminar etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 30 - 40% weightage on modules 1 to 3 and 60 - 70% weightage on modules 4 to 6.

			AY	2023-24		
				Information		
Progra	mme		B.Tech. (CSE, IT	, Electrical, Electronics	;)	
Contraction of the local division of the loc	Semester		First Year B. Tec	and the second se		
Course	Code		7AM102			
Course	Name		Engineering Mec	hanics		
Desire	l Requisi	tes:	Physics			
	feaching			Examination Schem		
Lectur		2 Hrs/week	MSE	ISE	ESE	Total
Tutori	al		30	20	50	100
				Credits: 2		
			C	Objectives		
1	To imper	t knowledge on	fundamentals of m	Objectives echanics		
2				d system of forces in stat	tics and dynam	lics
3				engineering applications		
				ith Bloom's Taxonomy	Level	
At the	end of the	course, the stud	ents will be able to	,		
со		Course	e Outcome Statem	ent/s	Bloom's Taxonomy Level	Bloom's Taxonomy Description
CO1	Explain f	fundamental con	cepts in statics and	dynamics	II	Understandin
CO2			epts of mechanics	to solve problems on	Ш	Applying
CO3	static sys		mation D'Alamh			
COS			ms related to dyna	erts and work energy mic systems	Ш	Applying
Modul	e		Module C	ontents		Hours
I	Funda force Lami	systems. Free I 's Theorem		and Resolution, Resultations of Forces, Varignon		5
11	Conce Loads		leactions Principle	acy, Equilibrium of bear of Virtual Work and its		4
111	Centro Sectio	ons, Radius of gy	Centroid, Moment ration, Mass-Mom	of Inertia of Plane figur tent of Inertia.	e, Composite	5
IV	Rectil	ve Motion, Rela	particle, Equation	ns of motion, Motion u ar and angular motion,		5
v	Kinet Frictio Newto	ics of Particles on: Laws of fri on's laws of m ed plane, lift, an	otion, D'Alember	of laws of friction, we ts principle, Application s, Circular motion, Rota	ns to rough	4
v	Project Kinet Friction Newton incline bodies	ctile. ics of Particles on: Laws of fri on's laws of m ed plane, lift, an	ction, application otion, D'Alember	of laws of friction, we ts principle, Applicatio	dge friction,	4

SB

Course Contents for BTech Programme, Applied Mechanics Department, AY2023-24



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VI			mpulse					5.00	, 24.	01 00	1501 / dil		5	
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	Kinet	tic Ene	rgy due	to Imp	pact									
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2			S. S I Publis					κ. G.	"Engi	neering	Mech	nanics"	, Nev	v A
3	Beer,	F. P. :		nnston,	E. R. "	Vector	Mech	anics fo	or Engi	neers V	ol. I ar	nd II",	McGra	aw H
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	4 th Ec Meria 6 th Ec	dition. am, L. dition.	and L.C	G. Krai	ge, "En	Usef	ng Me ul Lini	chanics ks			_	and a street		
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Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

For passing a theory course, Min. 40% marks in (MSE+ISE+ESE) are needed and Min. 40% marks in ESE are needed. (ESE shall be a separate head of passing)

B·B

N'se

Course Contents for BTech Programme, Applied Mechanics Department, AY2023-24



		X 7	alahand Calla	a of Engineering	angli	
		••		ge of Engineering, S ided Autonomous Institute)	angn	
			A	Y 2023-24		
			Cour	se Information		
Progra			B. Tech. (Electron			
	Semest	er	First Year B. Tech	n., SemII		
	e Code		7CM106	1		
	e Name	• • • • • • • • • • • • • • • • • • • •	Civil & Mechanic	al Engineering		
Desire	d Requi	sites:				
Te	eaching	Scheme		Examination Schem	e (Marks)	
Lectur		3Hrs/week	MSE	ISE	ESE	Total
Tutori		-	30	20	50	100
	-			Credits: 3		
				rse Objectives		
1				lamental principles and co		
*				nodynamics, materials sci		
2		oduce student		chanical engineering, its h	istory, scope, a	ind its importance
		Jus muusuies.				
		Cou	rse Outcomes (CC) with Bloom's Taxonon	ny Level	
At the	end of the	ne course, the	students will be abl	le to,	•	
~ ~		~			Bloom's	Bloom's
CO		Co	urse Outcome Sta	tement/s	Taxonomy Level	7 Taxonomy Description
CO1	Identif	v suitable	materials for e	engineering applications		Understanding
		·		ocesses, and understand		
				various industries and b	e	
CO2			ustry practices and a			
02		·	e	analyze and solve basi nechanical systems and		Applying
	compo		ins related to r	neenamear systems an		rippiying
	· •					
Modu	le					
				ents [Mechanical]		Hours
			gineering Material	s, Properties of engined	•	5
	(me	etals, polymer	gineering Material s, ceramics) Mater	s, Properties of engined ial selection consideration	s for compute	s r
I	(me har	etals, polymer dware and ro	gineering Material s, ceramics) Mater obotics application	s, Properties of engineer ial selection consideration s Material testing and o	s for computer characterization	s r 1 6
	(me har tecl	etals, polymer dware and ro nniques, Ove	gineering Material s, ceramics) Mater obotics application rview of manufac	s, Properties of engineer ial selection consideration s Material testing and o turing techniques (casting	s for compute characterization ng, machining	6 5 7 1 6
	(me har tecl mo	etals, polymer dware and ro nniques, Ove lding, etc.) R	gineering Material s, ceramics) Mater obotics application rview of manufac apid prototyping n	s, Properties of engineer ial selection consideration s Material testing and o	s for compute characterization ng, machining	6 5 7 1 6
	(me har tech mo for	etals, polymer dware and ro nniques, Ove lding, etc.) R computer har	gineering Material s, ceramics) Mater obotics application rview of manufac apid prototyping n dware prototypes.	s, Properties of engineer ial selection consideration s Material testing and o turing techniques (casting	s for compute characterization ng, machining er cutting, etc.	6
	(me har tecl mo for The	etals, polymer dware and ro nniques, Ove lding, etc.) R computer har ermodynamics	gineering Material s, ceramics) Mater obotics application rview of manufac apid prototyping n dware prototypes. s and Heat Manage	s, Properties of engined ial selection consideration s Material testing and o turing techniques (castin nethods (3D printing, lase	s for compute characterization ng, machining er cutting, etc.	5 r 1 6) 5
	(me har tecl mo for The and har	etals, polymer dware and ro nniques, Ove lding, etc.) R computer har ermodynamics heat transfe dware, Electr	gineering Material s, ceramics) Material obotics application rview of manufac apid prototyping n dware prototypes. s and Heat Manager r Heat dissipation onic Packaging an	s, Properties of enginee ial selection consideration s Material testing and o turing techniques (castin hethods (3D printing, lase ment, Basic concepts of the and thermal management d Cooling Packaging con	s for computer characterization ng, machining er cutting, etc. nermodynamics nt in compute ssiderations for	6 6 6 6 7 6
I	(me har tecl mo for The and har con	etals, polymer dware and ro nniques, Ove lding, etc.) R computer har ermodynamics heat transfe dware, Electr nputer compo	gineering Material s, ceramics) Material obotics application rview of manufac apid prototyping n dware prototypes. s and Heat Manages r Heat dissipation onic Packaging an onents and devices	s, Properties of engined ial selection consideration s Material testing and o turing techniques (castin nethods (3D printing, lase ment, Basic concepts of the and thermal management	s for computer characterization ng, machining er cutting, etc. nermodynamics nt in compute ssiderations for	6 6 6 6 7 6
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I	Module 1: Introduction to Civil EngineeringScope of civil engineering, Disciplines of civil engineeringRole of Civil Engineers in infrastructure developmentBuilding Systems: Conceptualization, Need for buildings, DefiningSustainability for Building systems, Structural systems; Load bearing,Framed, Prefabricated, Pre Engineered Construction, Loads on Building,Components in Buildings and their functions, building bye laws, Principle ofbuilding planning	5
Π	Module 2: Construction MaterialsConstruction materials and classificationProperties and uses of stone, brick, tile, timber, cement, sand, lime, mortar,concrete, bitumen and steel.	4
III	Module 3: Urban Infrastructure Urban Planning and Infrastructure, Transport systems, Water supply and drainage, Waste management facilities, Concept of smart city	4
	Text Books[Mechanical]	
1	Materials Science and Engineering: An Introduction" by William D. Callister Jr. an Rethwisch, 10th ed. 2018 edition, Wiley.	nd David G.
2	Thermodynamics: An Engineering Approach" by Yunus A. Çengel and Michael A edition.2017, McGrahill	. Boles, 8 th
	Text Books[Civil]	
1	Bhavikatti S.S "Basic Civil Engineering", I.K. International Publishing House Pvt.	
2	Hirasakar G. K., "Basic Civil Engineering", DhanpatRai publications, 1st Edition,	
3	Gole L.G., "Introduction to Civil Engineering", Mahu Publisher House, 4th Edition	n, 2005
	Deferences[Machanica]]	
	References[Mechanical] Manufacturing Engineering and Technology (SI Edition), <u>Serope Kalpakjian</u> , Stev	ven R. Schmid.
1	SI edition, 2018, Pearson	
	References[Civil]	
1	Bindra S.P., Arora S.P., "Building Construction", Dhanpat Rai publication, 5th edi	
2	Smart Cities Mission Statement & Guidelines, Ministry of Urban Development Go India	overnment of
	пша	
	Useful Links[Mechanical]	
1	https://ocw.mit.edu/courses/mechanical-engineering/	
2	https://www.coursera.org/browse/engineering/mechanical-engineering	
3	https://www.edx.org/learn/mechanical-engineering	

			CO-P	O Map	ping H	For Ele	ectrica	l Engi	neerin	g Depa	artmei	nt				
		Programme Outcomes (PO)												PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2		
CO1	2				1					1		1				
CO2			1													
CO3					2					1						
The stren	gth of 1	mappir	ig is to	be wr	itten as	,1,2,3;	Where	e, 1:Lo	w, 2:N	ledium	n, 3:Hig	gh				

	CO-PO Mapping Electronics Engineering Department														
	Programme Outcomes (PO)													PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	
CO1	1				1					1					
CO2			1												

CO3					2					1				
The stren	gth of 1	nappir	ng is to	be wri	itten as	1,2,3;	Where	e, 1:Lo	w, 2:M	ledium	, 3:Hig	zh		

O Mapping Computer Science and Engineering Depart	t
Programme Outcomes (PO)	PSO
3 4 5 6 7 8 9 10 11	1 2
3 1	
1	
3 1	
1	

		C	CO-PO	Mapp	oing Fo	or Info	ormati	on Tec	hnolo	gy Dep	partme	ent			
		Programme Outcomes (PO)												PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	
CO1					3					1		1			
CO2			1												
CO3					3					1					
The stren	gth of 1	mappir	ng is to	be wr	itten as	1.2.3:	Where	e. 1:Lo	w. 2:N	ledium	n. 3:Hig	2h	-		

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Walc		e of Engineerin ed Autonomous Institu			
				2023-24	,		
			Course	Information			
Progra	amme		B. Tech. (Electr	onics Engineering)			
Class,	Semester		First Year B. Te	ech., SemII			
Cours	e Code		7EN102				
	e Name		Digital Electron				
Desire	d Requisi	tes:	Engineering Phy	ysics			
	Teaching	Scheme		Examination S	Scheme (Marks)		
Lectur		3 Hrs/week	MSE	ISE	ESE		Total
Tutori	ial	-	30	20	50		100
				Cre	dits: 3		
		1	1				
	I			e Objectives			
1			now the number sy				
2 3				combinational and s	sequential circuits		
3	Able to c	listinguish the c	ombinational and	sequential circuits			
		Course	Outcomes (CO)	with Bloom's Taxo	nomy Level		
At the	end of the		lents will be able				
CO1				in the digital system	ns	Unde	rstand
CO2		and combination					rstand
CO3		and the sequentia					rstand
CO4		lesign small dig					eate
CO5	Understa	ind the sequent	ial circuits using st	tate diagram		Unde	rstand
Modu	le		Mod	ule Contents			Hours
			tion to Number S				
Ι	Intro	duction to num	iber system. Bina	ry, Hex BCD, Gra	y code, Arithmetic		8
1	opera	ations, Addition	, Subtraction on	binary, Hex, BCD	numbers.		0
	Mod	ule 2: Logic Gat	tes				
	Revi	ew of logic gate	es, NAND/NOR a	as universal gates,	tri-state logic, alge	braic	
II	mini	mization (min-t	erms, max- terms	s), K-map minimiz	ation, Realization	using	8
	gates	,converting AC	OI to NAND/NOF	R			
	Mod	ule 3: Combina	tional Circuits				
III	Desi	gn of comparate	or, Adder/subtrac	tor, Code converte	rs, Introduction to	MUX /	7
	DEM	IUX					
	Mod	ule 4 : Module	4 Sequential Cir	cuit			
IV	· ·	lop, asynchrond nine & Moore N		d N Counters, BCI	D counters, Mealy		7
	Mod	ule 5: State Dia	gram				
V				e Reduction. Merge	r Char methods		6
	Mod	ule 6 : Algorithn	nic State Machine	2			
VI		-		xamples of ASM cha	arts		3

	Textbooks
1	John F. Wakerly, "Digital Design", Pearson Education Publication, 4 th edition, 2008.
2	Anand Kumar, "Fundamentals of Digital Circuits", PHI, 2 nd Edition, 2009.
3	MandalS.K , "Digital Electronics" 1 st Ediction.Mc-Graw-Hill, 2009.
	References
1	RP.Jain, "Modern Digital Design", Mc-Graw-Hill, 4 th edition, 2010.
2	Morris Manno, "Digital Logic and Computer Design", Prentice-Hall India, 4 th edition, 2014
	Useful Links
1	http://learn-aboutelectronics.com
2	

						CO-PC) Mapp	oing						
		Programme Outcomes (PO) PSO									50			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2													
CO2		2												
CO3														
CO4			2											2
CO5		2												
The streng	gth of r	napping	g is to b	be writt	en as 1	: Low,	2: Med	ium, 3:	High					
Each CO	of the c	ourse 1	nust m	ap to at	least c	one PO.								

Assessment	
rassessment	

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

For passing a theory course, Min. 40% marks in (MSE+ISE+ESE) are needed and Min. 40% marks in ESE are needed. (ESE shall be a separate head of passing)

		and College of Government Aided Ai			
	(AY 202			
		Course Inf	-		
Programme		B. Tech. (Electron			
Class, Semest	ter	First Year B. Tech	e		
Course Code		7PH155	.,		
Course Name		Engineering Physi	cs Lab.		
Desired Requ				basic practical know	ledge up to HSC
-	hing Scheme			Scheme (Marks)	
Lecture	-	LA1	LA2	Lab ESE	Total
Tutorial	-	30	30	40	100
Practical	2 Hrs/week				
Interaction	-		Cre	dits: 1	
		Course Ol	ojectives		
1	To gain practical known the physics theory.	wledge by applying	the experimenta	l methods to correla	te with
2	To learn the usage of	electrical and optic	al systems for var	rious measurements.	
3	To Apply the analytic	cal techniques and g	graphical analysis	to the experimental	data.
	Course O	utcomes (CO) with	Bloom's Taxon	omy Level	
C01	Calculate the diamete of liquid / radius of optical active subst Velocity of sound in the expression for the	curvature of Plano ances, I-V charac air, Calculate R.T	convex lens, S teristics of Sem for specific hall/a	pecific rotation of iconductor diode,	Applying
CO2	Demonstrate Hartley of light by Plane diff	and Colpitt's osci	llator and simula		Applying
		List of Experiment			
	List of Expen	riments/ Lab Activ	ities- Any Eight	Experiments	
1	Find the diameter of		•		
2	Determination of way			grating.	
3	Determine the Specif	ic rotation of sugar	solution		
4	Find the wavelength		-		
5	Verify the expression				
6	Measure the wavelen	gth of ultrasonic wa	ives by Kundt's t	ube method.	
7	Design and simulate	<u> </u>	Oscillator.		
8	Determine the Planck				
9	Study the I-V charact				
10	Newton's ring: Deter curvature of Plano co		ngth of light and	refractive index of li	iquid /radius of
11	To calculate the reve		ecific hall.		
12	Determination of Fer	mi energy of coppe	r using a Wheatst	one bridge.	
	•	Text B			
1	C. L. Arora "Practic				
2	P.R. Sasi Kumar "Pr			Ltd 1st edition 2011	
		Refere			
1	Halliday, Resnic and				
2	A. Beiser, "Concepts				ition, 2003.
3	Ajoy Ghatak, "Optic			12.	
		Useful 1			
1	https://nptel.ac.in/cou		05121/		
2	https://www.iitg.ac.in	· · · · · · · · · · · · · · · · · · ·			
3	https://youtu.be/imH	vRBOMg84			

				CO-	PO Maj	pping l	For Al	l B.Te	ch. Pr	ogram	5							
					Progra	amme	Outco	mes (I	PO)					PSO				
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3			
CO1	1	1																
CO2	2																	
	The	streng	th of n	nappin	g is to b					1:Low,	2:Med	ium, 3	:High					
						ssment	````											
					mponei													
IMP: Lab I				head o														
Assessmen	t		sed on		Condu					edule	-	week	Sem)	Μ	Marks			
LA1			ctivitie	-		Course				to Wee					30			
2/11	a	ttendar	-			culty				ion at t		of Wee	ek 6					
LA2			ctivitie	/		Course		0	Veek 7	1 10		30						
	a	ttendar	0			culty				ion at t		of Wee	ek 12					
Lab ESE			ctivitie	-		Course		During Week 15 to Week 18 Marks Submission at the end of Wee							40			
West 1 indi		ttendar	· J			ulty							-					
Week 1 indi 26-week sen																		
include perf															snan			
activities, as															-10			
experiments				1					r -					j - e				
^			As	sessm	ent Plar	ı based	on B	loom's	Taxo	nomy I	Level							
Blo	om's	Taxon	omy I	Level		I	LA1		LA	2	La	b ESE		Tota	al			
	F	Remem	ber				10		10			15		35				
	U	Jnderst	and				10		10			10		30				
		Appl	у				10		10			15		35				
		Analy					0		0			0		0				
		Evalua	ite				0		0			0		0				
		Creat	e				0		0			0		0				
		Tota	1				30		30			40		100)			

		Wale		ollege of vent Aided A	utonomous l		angli	
				AY 202				
D				Course Inf				
Program				(Electronics		ng)		
Class, Se Course C			7HS101	r B. Tech. S	sem11			
Course C Course N				ication & C	Jeneric skil	10		
	anne Requisites:		10+2 leve		Jenerie skii	15		
	requisitest	·	10121010	Linghish				
Te	aching Scl	heme			Examination	n Scheme	(Marks)	
Lecture			LA1	LA2		ESE	· ,	Total
Tutoria			30	30		40		100
Practica		2Hrs/week						100
Interact		1Hr/week				Credits:	2	
meraci		IIII/ WCCK				ci cuits.		
				Course O	biectives			
1	Enable	the students to	communica		U	ecision.		
							ession required	for
2		ofession and en						
	Provide	relevant know	ledge about	t generic sk	tills, its imp	ortance a	nd enable them	to understand
3	persona	l attributes like	commitme	ent, loyalty,				
		ure exposure to				1		
4							k effectively in	
	and teac						nd technologica	l skills.
CO1	Commu	nicate clearly,		es (CO) with				Apply
		basic proficier	<u> </u>		-			
CO2		hension, writing					ing	Understand
	-	Lifelong Learn		-	ve attitude.	lovalty.		
CO3		ment, reliability					nerself	Apply
	physical	lly, intellectual	ly and psyc	hologically	<i>'</i> .			
CO4		thically and eff				ige tasks		Apply
0.04	effective	ely and apply k	nowledge t	to solve pro	oblems.			rppiy
				110				
Module				odule Cont				Hours
	Modu	le 1: Introdu	iction to	communi	icative Eı	nglish		
		damentals						
	2. Elei							
Ι	3.Proc							
I	4.Typ 5.Barı							02
	5.Bari	lers						
			ood interr	orsonal a	nd intrano	reonal el	zille	
	6.Nee	d to develop g						
	6.Nee 7.Deve	d to develop g cloping effectiv						
	6.Nee 7.Deve note m	d to develop g eloping effectiv naking)	ve Listenir	ng Skills (t	ypes, Barr	riers, list	ening and	
	6.Nee 7.Deve note m Modu	d to develop g eloping effectiv naking) le2: Commu	ve Listenir	ng Skills (t	ypes, Barr	riers, list	ening and	
	6.Nee 7.Deve note m Modu Vocal	d to develop g eloping effectiv naking) le2: Commu pulary.	ve Listenii nicative(ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	
	6.Nee 7.Deve note m Modu Vocal 1.Mod	d to develop g eloping effectiv naking) le2: Commu	ve Listenii nicative(ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	
	6.Nee 7.Deve note m Modu 1.Mod 2.Ques 3.Misp	d to develop g eloping effective naking) le2: Communi- oulary. al verbs, non-tags olaced Modifie	ve Listenii nicative(modal ver	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	
	6.Nee 7.Deve note m Modu 1.Moda 2.Ques 3.Misp 4.Pass	d to develop g eloping effectiv naking) le2: Commun oulary. al verbs, non-r stion tags olaced Modifie ives	ve Listenii nicative(modal ver	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	
	6.Nee 7.Deve note m Modu 1.Moda 2.Ques 3.Misp 4.Pass	d to develop g eloping effective naking) le2: Communi- oulary. al verbs, non-tags olaced Modifie	ve Listenii nicative(modal ver	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	
II	6.Nee 7.Deve note m Modu 1.Moda 2.Ques 3.Misp 4.Pass 5.Phra Vocal	d to develop g eloping effectiv naking) le2: Commun oulary. al verbs, non-t stion tags olaced Modifie ives sal verbs oulary:	ve Listenii nicative(modal ver	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	05
II	6.Nee 7.Deve note m Modu Vocal 1.Mod 2.Ques 3.Misp 4.Pass 5.Phra Vocal 1. Com	d to develop g eloping effectiv naking) le2: Commun oulary. al verbs, non-n stion tags olaced Modifie ives usal verbs oulary: nectives,	ve Listenii nicative(modal verl rrs	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	05
II	6.Nee 7.Deve note m Modu Vocal 1.Mod 2.Ques 3.Misp 4.Pass 5.Phra Vocal 1. Com 2. Pref	d to develop g eloping effective naking) le2: Communi- oulary. al verbs, non-re- stion tags blaced Modifie ives usal verbs oulary: nectives, ixes and suffic	ve Listenii nicative (modal ver ers xes,	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	05
II	6.Nee 7.Deve note m Modu 1.Modu 2.Ques 3.Misp 4.Pass 5.Phra Vocal 1. Com 2. Pref 3.Sync	d to develop g eloping effective naking) le2: Communi- bulary. al verbs, non- stion tags blaced Modifie ives usal verbs bulary: nectives, ixes and suffit onyms and An	ve Listenii nicative (modal ver ers xes, tonyms	ng Skills (t G rammar	ypes, Barr & Develo	riers, list oping a	ening and	05
II	6.Nee 7.Deve note m Modu 1.Mod 2.Ques 3.Misp 4.Pass 5.Phra Vocal 1. Com 2. Pref 3.Sync 4.one-	d to develop g eloping effective naking) le2: Communi- oulary. al verbs, non-to stion tags blaced Modifie ives usal verbs oulary: nectives, ixes and suffit onyms and An- word substitu	ve Listenii nicative (modal ver ers Xes, tonyms tions ,	ng Skills (t G rammar bs ,semi-m	ypes, Barr & Develo	riers, list oping a	ening and	05
II	6.Nee 7.Deve note m Modu 1.Moda 2.Ques 3.Misp 4.Pass 5.Phra Vocal 1. Com 2. Pref 3.Sync 4.one- 5.Re-a	d to develop g eloping effective naking) le2: Communi- bulary. al verbs, non- stion tags blaced Modifie ives usal verbs bulary: nectives, ixes and suffit onyms and An	ve Listenii nicative (modal ver ers Xes, tonyms tions ,	ng Skills (t G rammar bs ,semi-m	ypes, Barr & Develo	riers, list oping a	ening and	05

	Module 3 : Formal Communication Skills	
III	 a. Oral skills: Developing non-verbal skills. 1.Extempore /Public Speaking Skills (speeches) 2.Group Presentation 3.Individual Presentations 	05
111	 b. Written Skills: 1.Paragraph Writing 2.Comprehension passage 3.Inter-office communication – Memorandums ,Circulars 4.Report Writing 	05
IV	 Module 4: Introduction to Generic Skills a. Importance of Generic Skill Development (GSD) b. Global and Local Scenario of GSD c. Lifelong Learning (LLL) and associated importance of GSD. 	01
	Module 5: Self-management skills	
	1. Knowing Self for Self-Development. (01 hrs)	
	a. Self-concept.	
	b. Attitude,	
	c. Self-esteem.	
	d. Self-confidence.	
	e. Self-motivation.	
	2 Personal Attributes (02 hrs)	
	a. Loyalty. b. Commitment.	
	c. Honesty and integrity.	07
V	d. Reliability.	
	e. Enthusiasm.	
	f. Balanced attitude while studying, working and home life.	
	3. Managing Self – Physical (02 hrs)	
	a. Personal grooming. b. Health, Hygiene. c. Time Management	
	c. Time Management. 4. Managing Self – Psychological (02 hrs)	
	a. Stress, Emotions, Anxiety- concepts and significance.	
	b. Exercises related to stress management.	
	c. Techniques to manage the above.	
	Module 6: Teamwork Skills	
	1. Team Building (01 hrs.) Definition, hierarchy, team dynamics.	
	2. Team related skills. (02 hrs)	
	a. Sympathy, empathy.	
	b. co-operation, concern, lead and negotiate.c. work well with people from culturally diverse background.	
	3. Technological Skills. (02 hrs.) a. Task Initiation, Task Planning, Task execution, Task close out	07
VI	b.Exercises/case studies on task planning towards development of skills for task management.	07
	 4. Problem Solving skills. (02 hrs.) a. Prerequisites of problem solving- meaningful learning, ability to apply knowledge in problem solving. b. Different approaches for problem solving. 	
	c. Steps followed in problem solving.d. Exercises/case studies on problem solving.	

	Text Books
1	Textbook: Sanjay Kumar, Pushpalata, Communication Skills, Oxford University Press, First edition ,2012
	References
1	Ashraf Rizvi, Effective Technical Communication, Tata McGraw Hills publishing
1	Company 2006
2	William Sanborn Pfeiffer, T.V.S. Padmaja, Technical Communication: A Practical
2	Approach, Pearson, Sixth Edition 2012
3	Exercises in Spoken English, Parts 1 and II CIEFL, Hyderabad, Oxford University Press
	Useful Links
1	www.oupinheonline.com
2	www.scitechpublications.com

						CO-P	O Maj	pping							
		Programme Outcomes (PO) PSO													
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1										1					
CO2										1					
CO3									2			2			
CO4								2	3						
The strengt	h of m	apping	is to b	e writt	en as 1	,2,3; W	/here,	1: Low	, 2: M	edium,	3: Hig	, jh			
Each CO of	f the co	ourse n	nust ma	p to at	least o	one PO).								

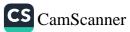
Assessment

The assessment is based on two In-semester evaluations (LA) of 30 marks each, one End-semester examination (ESE) of 40 marks.

LA1 and LA2 are based on the modules taught (typically Module 1-3) and ESE is based on all modules with 30-40% weightage on modules before LA1 and 60-70% weightage on modules LA2.

Assessi	Assessment Plan based on Bloom's Taxonomy Level						
Bloom's Taxonomy Level	LA1	LA2	ESE	Total			
Remember							
Understand	10	10	10	30			
Apply	20	20	30	60			
Analyse							
Evaluate							
Create							
Total	30	30	40	100			

			A	Y 2023-24			
the same to be a set of the			Cours	e Information			
Progr	amme		B.Tech. (All Bra	nches)			
Class,	Semester	•	First Year B. Teo	ch., Sem I/II			
Cours	e Code		7AM155				
Cours	e Name		Engineering Med	chanics Lab			
Desire	d Requis	ites:	Engineering Med	chanics			
	Teaching	Scheme		Examinatio	n Scheme ((Marks)	
Practi	ical	2 Hrs/ Week	LA1	LA2	Lab	ESE	Total
Intera	ction		30	30	4	0	100
				С	redits: 1		
	,			se Objectives			
1			ctice for the condu			ne principles of	fmechanics
2	To demo	onstrate the grap	hical methods to v	erity the analytica	al solutions		
		Course	e Outcomes (CO)	with Bloom's Ta	axonomy L	evel	
At the	end of the		lents will be able to				
						Bloom's	Bloom's
СО		Cour	rse Outcome State	ement/s		Taxonomy	Taxonon
001	Deserve	······································	of laws and has			Level	Descriptio
C01	1	experiments.	n of laws and bas	ic principles of i	nechanics	Ш	Applying
CO2			to solve problem	s on force system	n beams		
	and fram		P		,,	Ш	Applying
_		I	list of Experimen	ts / Lab Activitie	s/Topics		
List of	Experim	ents :					
1 1/1-1	Castion of	[]	- 6 6				
		f law of triangle f law of polygon					
			tions for Simply Su	ipported Beam			
4. Veri	fication of	f the principle of	moments using B	ell crank lever ap	paratus		
5. Dete	rmination	of the coefficient	nt of friction for m	otion on horizont	al plane		
			nt of friction for m			19	
			n-concurrent copla		by graphica	l method	· · ·
			ate beams by graph plane frames by g			bh c c c	
7. Ana	., sis or pi	. Jonned perfect	plane frames by g	rapinear method			1
			Т	extbooks			
1	Lab N	Manual Link - ht	tps://atifmohd077.		om/2019/03	/em-lab-manua	al-1.pdf
2	Lab	Manual Lin	ks - https://je	cassam.ac.in/wp-			
			y-2nd-SEM-DU-C		-		
3			Rajashekarappa.,	K. G. "Engineer	ing Mechai	nics", New Ag	e Internatior
	Publi	shers, 2015, 5 th I	cattion.				
			Da	ferences			
1		mrutham., S. ' ed, 2008.	Textbook of Ap		", Dhanpa	t Rai Publish	ing Compa
	Beer,	F. P. and Johns	ston, E. R. "Vecto , 2011, 9 th Edition.	r Mechanics for	Engineers	Vol. I and II",	McGraw H
2		in a sineation					
			ering Mechanics"	Laxmi Publidation	ns.ltd		
2		Bansal "Engine	ering Mechanics"	Laxmi Publication	ns.ltd.		



	Useful Links
1	https://nptel.ac.in/courses/112106286
2	https://www.youtube.com/watch?v=9Yt314bP-90
3	https://www.vlab.co.in/broad-area-civil-engineering
4	Virtual Lab link by IIT Mumbai - http://vlabs.iitb.ac.in/vlab/labsme.html

	Programme Outcomes (PO)													PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2		
COI				1												
CO2		1														

Each CO of the course must map to at least one PO, and preferably to only one PO.

		Assessment		
		b assessment, LA1, LA2 an of passing.(min 40 %), LA	nd Lab ESE. 1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
	Lab activities,		During Week 1 to Week 8	
LAI	attendance,	Lab Course Faculty	Marks Submission at the end of	30
	journal		Week 8	
	Lab activities,		During Week 9 to Week 16	
LA2	attendance,	Lab Course Faculty	Marks Submission at the end of	30
	journal		Week 16	
	Lab activities,	Lab Course Faculty and	During Week 18 to Week 19	
Lab ESE	journal/	External Examiner as	Marks Submission at the end of	40
	performance	applicable	Week 19	

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

Bron

Course Contents for BTech Programme, Applied Mechanics Department, AY2023-24





		W		ge of Engineering		
			A	Y 2023-24		
			Cour	rse Information		
Progra	amme		B. Tech. (Electror	nics Engineering)		
Class,	Semest	er	First Year B. Tecl	h. SEM-II		
Course	e Code		7CM156			
Course	e Name	•	Civil & Mechanic	al Engineering Lab		
Desire	d Requ	isites:	NA			
Te	eaching	Scheme		Examination Sch	eme (Marks)	
Practio	cal	2Hrs/Week	LA1	LA2	ESE	Total
Intera	ction	-	30	30	40	100
				Credit	s: 1	
		1	1			
			Cou	ırse Objectives		
1			ounding in the fund	amental principles and		nanical engineering
1	includ	ing mechanics,	thermodynamics, r	naterials science, and f	luid mechanics	
2			to the field of mec	hanical engineering, its	s history, scope, a	nd its importance
-	ın vari	ous industries.)) with Plaam's To		
At the	end of t		students will be able	D) with Bloom's Taxo e to	iomy Level	
		e Outcome Sta			Bloom's	Bloom's
co	00020				Taxonom	
					Level	Description
	To un	derstand mecha	nical testing and in	spections, such as hard	Iness II	Understand
CO1	testing	g, non-destruct	tive testing (e.g.,	ultrasonic testing),		
		sional measure				
CO2				hermodynamics and heat	at II	Apply
				ion through different	nts	
~~~				bility of elements in		
CO3		ng drawing.	8		II	Understandin
CO4	Exami	ne the material	properties and con	nment on their quality.	III	Applying
CO5	Use su	rveying equipr	nent to measure dis	tance and area.	III	Applying
			List of Expe	riments / Lab Activiti	es	
Mecha				<i>a</i> 1 1		
1. 2.			measurements and a	flaw detection. discontinuity examinat	ion	
2. 3.	-	•		vell, Brinell hardness te		
4.			•	dy of Stress vs Strain c		
5.	Eddy	current and aco	ustic emission flaw	measurement techniqu	ies.	
				anical testing. Only De	emonstration.	
Modu	le Wis	e Measurable	e Students Learn	ing Outcomes:		
• U	pon con	npletion of this	laboratory course,	students will be able to	understand the si	mple mechanical
pr	operties	s of materials.				_
• Tł	ney will	also get practi	cal knowledge of th	ne non-destructive testin	ng.	
	Exerci		U		-	
1.	Study	and identify ba	sic elements in			
	i) Si	te plan,				
	··· D1	an, elevation ar	nd section of a resid	lential building		
	11) PI	,		•		
2.	Study	water supply a		of a residential building		
2. 3.	Study			-		

5.	Measurement of distance and area
Demor	nstration of Total station
	Text Books [Mechanical]
1	Raghuwanshi B. S.,"A Course in Workshop Technology I", Dhanpat Rai Publications, 10th Ed., 2009
2	S. K. Hajra Choudhury and A. K. HajraChoudhary, "Workshop Technology" – Vol I [Manufacturing Processes]", Media Promoters and Publishers Pvt. Ltd., 10th edition, reprint 2001
3	Bawa . H S . "Workshop Practice," McGraw Hill Education, Noida, 2 nd edition ,2009 ISBN-13: 978-0070671195
4	Gupta, J. K. ; Khurmi, "A Textbook of Manufacturing Process" (Workshop Tech.) R S S Chand and Co., New Delhi,2020, ISBN:81-219-3092-8
5	Singh Rajender, "Introduction to Basic Manufacturing Process and Workshop Technology ",New Age International, New Delhi; 2014, ISBN: 978-81-224-3070-7
	References [Mechanical]
1	W.A.J. Chapman, "Workshop Technology Volume I", CBS Publishing & Distributors, Delhi. [ISBN-13:9788123904016] 2001
2	Rao P.N., "Manufacturing Technology", Vol. I and Vol. II, Tata McGraw Hill House, 2017
3	Gowri P. Hariharan and A. Suresh Babu, "Manufacturing Technology – I" Pearson Education, 2008
	Text Books [Civil]
1	Hiraskar G. K., "Basic Civil Engineering", DhanpatRai publications, 1st Edition,2007
2	Gole L.G., "Introduction to Civil Engineering", Mahu Publisher House, 4th Edition, 2005
3	Bhavikatti S.S., "Basic Civil Engineering", New Age Publications, 2010
	References [Civil]
1	Duggal S.K., "Surveying (Vol I)", Tata McGraw Hill, 4th edition 2013
2	Bindra S.P., Arora S.P., "Building Construction", DhanpatRai publication, 5th edition, 2012
	Useful Links
1	https://www.vlab.co.in/broad-area-mechanical-engineering

	CO-PO Mapping For Electrical Engineering Department																										
		Programme Outcomes (PO)												PSO													
	1	2	3	4	5	6	7	8	9	10	11	12	1	2													
CO1	3		1							1		1															
CO2	3		1																								
CO3						2				1																	
The stren	gth of a	mappir	ig is to	be wri	itten as	,1,2,3;	Where	e, 1:Lo	w, 2:N	ledium	, 3:Hig	gh			The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High												

CO-PO Mapping Electronics Engineering Department																
		Programme Outcomes (PO)												PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2		
CO1	3		1							1						
CO2	3		1													
CO3						2				1						
The stren	The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High															

	CO-PO Mapping Computer Science and Engineering Department															
		Programme Outcomes (PO)												PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2		
CO1	3		1				3			1		1				
CO2	3		1				3									
CO3						2				1						
The stren	The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High															

CO-PO Mapping For Information Technology Department	
Programme Outcomes (PO)	PSO

	1	2	3	4	5	6	7	8	9	10	11	12	1	2	
CO1	3		1							1		1			
CO2	3		1												
CO3						2				1					
The stren	gth of 1	mappir	ng is to	be wri	itten as	1,2,3;	Where	e, 1:Lo	w, 2:N	ledium	, 3:Hi	gh			

There are three	e components of lab as	sessment I A1 I	A2 and Lab ESE	
	<b>1</b>		2 together is treated as In-Semester Eva	luation.
Assessment	Based on	Conducted by	Typical Schedule (for 26-week	Marks
			Sem)	
	Lab activities,	Lab Course	During Week 1 to Week 6	
LA1	attendance, journal	Faculty	Marks Submission at the end of	30
	attenuance, journar	Taculty	Week 6	
	Lab activities	Lab Course	During Week 7 to Week 12	
LA2	Lab activities, attendance, journal	Faculty	Marks Submission at the end of	30
	attenuance, journar	Taculty	Week 12	
	Lab activities,	Lab Course	During Week 15 to Week 18	
Lab ESE		Faculty	Marks Submission at the end of	40
	attendance, journal	Гасину	Week 18	

considering a 26-week semester. The actual schedule shall be as per academic calendar. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments.

				led Autonomous Ins Y 2023-24		
				e Information		
Progra	ommo			onics Engineering	()	
	Semester		First Year B. Te	<u> </u>		
	e Code		7EN152			
	e Name		Digital Electron	ics I ab		
	d Requis	itos.	Physics			
Desire	u Kequis	ites.	1 1195105			
,	Teaching	Scheme		Examination	n Scheme (Marks)	
Practi		2 Hrs/ Week	LA1	LA2	Lab ESE	Total
Intera			30	30	40	100
					redits: 2	100
			Cour	se Objectives		
1	To know	about the logic				
2		the logic circui	<u> </u>			
3		<u> </u>				
				with Bloom's Ta	axonomy Level	
			lents will be able	to,		<b>XX 1</b>
CO1		and the working	-			Understand
CO2 CO3		build the Digit test the Circui				AnalyzeAnalyze
05	Able to	test the Chou				Anaryze
		T	ist of Experime	nts / Lab Activitie	es/Tonics	
List of	f Topics(A		nteraction mode			
1.50 01	r opros(r					
1. Rea	lization of	logic gates usin	g basic building	block (NAND/NC	DR).	
) Imm	lamantati	n of combinatio	and and accurate	al logio sinovit		
2. mp	iementatio		onal and sequentia	ai logic circuit.		
				`extbooks		
1					ublication, 5 th edition, 2	2018.
2				tal Circuits", PHI, 2		
4	Man	dalS.K <i>, "Digital</i>	Electronics" Mc-0	Graw-Hill, 1 st Edicti	on., 2009	
3						
			T	oforences		
			K	eferences	lition 2010	
3	RD	lain "Modern D		c-Graw-Hill 1 ^m od		
3			igital Design", M			lition 1979
3			igital Design", M		rentice-Hall India, 1 st ec	lition 1979.
3			igital Design", M tal Logic and Con	nputer Design", Pr		dition 1979.
3	Mor		igital Design", M tal Logic and Con Us			lition 1979.

	CO-PO Mapping														
		Programme Outcomes (PO)													
	1	2         3         4         5         6         7         8         9         10         11         12         1         2													
CO1	2														
CO2															
CO3															
The stre	ngth of	mappi	ng is to	be wri	tten as	1,2,3; v	where,	l: Low,	2: Mec	lium, 3	High				
Each CO	strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High a CO of the course must map to at least one PO, and preferably to only one PO.														

Assessment
There are three components of lab assessment, LA1, LA2 and Lab ESE.

IMP: Lab ESE is a separate head of passing.(min 40 %), LA1+LA2 should be min 40%

Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

		W		ge of Engineering, Sa Aided Autonomous Institute)	angli						
			ŀ	AY 2023-24							
			Cou	rse Information							
Progra	mme		B. Tech. (Electro	nics Engineering)							
	Semest	er	B. Tech. (Electronics Engineering) First Year B. Tech. SEM-II								
Course			7VS151								
	e Name		Engineering Skill	s-I							
Desire			NA	51							
Desire	u nequ	151(15).	1111								
Te	aching	Scheme		Examination Scheme	(Marks)						
Practic	-	2Hrs/Week	LA1	1	ESE	Total					
Intera		-	30	30	40	100					
mera			50	Credits: 1	-+0	100					
			Ca	ırse Objectives							
1	To tre	in the students		ls and equipments involved	in the manuf	tuning process					
				c cutting tools and devices							
2				viven job drawing, select rel							
3				various operations to make							
				terial requirement in constru							
4	FSI			•							
			· · · · · · · · · · · · · · · · · · ·	D) with Bloom's Taxonom	y Level						
At the	end of t	he course, the	students will be abl	e to,							
~~		G	0 4 04 4		Bloom's	Bloom's					
CO		Course	Outcome Stateme	ent/s	Taxonomy	Taxonomy					
	Til-sector	- ( - (			Level	Description					
CO1			ting tools for manu	s, machines, equipment, the	II	Understanding					
CO2			job holding devices		III	Apply					
CO2 CO3		<u> </u>	g line out and maso	¥		Understanding					
CO4		· · ·		ted to building plan.		Apply					
CO5			l requirement in con		II	Apply					
CO6	Sketch	n building plan			II	Apply					
	-				·	·					
			List of Exne	winn and a / I ah A adimitian							
			List of Expe	riments / Lab Activities							
List of	Experi	ments [Mecha	<del>_</del>	riments / Lab Activities							
	Introd	uction to wood	anical]: working,the hand	tools required and machines							
	Introd Perfor	uction to wood	anical]: working,the hand			are joint type] (4					
1.	Introd Perfor Hrs)	uction to <b>wood</b> m Planing ope	anical]: working,the hand eration,Cutting by	tools required and machines chisel to prepare small <b>wo</b>		are joint type] (4					
1.	Introd Perfor Hrs) Introd	uction to <b>wood</b> m Planing ope uction to <b>fittin</b>	anical]: working,the hand eration,Cutting by o g shop tools, equip	tools required and machines chisel to prepare small <b>wo</b> ment/machines:	o <b>den job</b> [Squa						
1.	Introd Perfor Hrs) Introd Job c	uction to <b>wood</b> m Planing ope uction to <b>fittin</b> onsisting of	anical]: working,the hand eration,Cutting by g shop tools, equip male and femal	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr	o <b>den job</b> [Squa						
1.	Introd Perfor Hrs) Introd Job c projec	uction to <b>wood</b> m Planing ope uction to <b>fittin</b> onsisting of tion,holes on b	anical]: working,the hand eration,Cutting by g shop tools, equip male and femal oth and their asser	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi	o <b>den job</b> [Squa roove, another ng.	with matching					
1. 2.	Introd Perfor Hrs) Introd Job c projec operat	uction to <b>wood</b> m Planing ope uction to <b>fittin</b> onsisting of tion,holes on b ions to be perfe	anical]: working,the hand eration,Cutting by of g shop tools, equip male and femal oth and their asser pormed:Marking,Put	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling,	oden job [Squa roove, another ng. Edge filing op	with matching perations (6 Hrs.)					
1. 2.	Introd Perfor Hrs) Introd Job c projec operat Introd	uction to <b>wood</b> m Planing oper- uction to <b>fittin</b> onsisting of tion,holes on b ions to be perfor- uction to <b>shee</b>	anical]: working,the hand eration,Cutting by of g shop tools, equip male and femal oth and their asser ormed:Marking,Pun t metal work : Job	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi	oden job [Squa roove, another ng. Edge filing op	with matching perations (6 Hrs.)					
1. 2.	Introd Perfor Hrs) Introd Job c projec operat Introd	uction to <b>wood</b> m Planing oper- uction to <b>fittin</b> onsisting of tion,holes on b ions to be perfor- uction to <b>shee</b>	anical]: working,the hand eration,Cutting by of g shop tools, equip male and femal oth and their asser ormed:Marking,Pun t metal work : Job	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b>	oden job [Squa roove, another ng. Edge filing op	with matching perations (6 Hrs.)					
<ol> <li>1.</li> <li>2.</li> <li>3.</li> <li>List of</li> </ol>	Introd Perfor Hrs) Introd Job c projec operat Introd follow	uction to <b>wood</b> m Planing operation to <b>fittin</b> onsisting of tion,holes on b ions to be performed uction to <b>sheet</b> ring operations	anical]: working,the hand eration,Cutting by or g shop tools, equip male and femal oth and their assert ormed:Marking,Put t metal work : Job : Marking,Cutting,I	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b> pending/folding (4 Hrs.)	o <b>den job</b> [Squa roove, another ng. Edge filing op v as per given j	with matching perations (6 Hrs.) ob drawing with					
1. 2. 3. <b>List of</b> 1.	Introd Perfor Hrs) Introd Job c projec operat Introd follow <b>Experi</b> Establ	uction to <b>wood</b> m Planing operation to <b>fittin</b> consisting of tion,holes on b ions to be performed uction to <b>sheet</b> ring operations <b>ments [Civil]:</b>	anical]: working,the hand eration,Cutting by of g shop tools, equip male and femal oth and their asser ormed:Marking,Put t metal work : Job : Marking,Cutting,t	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b>	o <b>den job</b> [Squa roove, another ng. Edge filing op v as per given j	with matching perations (6 Hrs.) ob drawing with					
1. 2. 3. <b>List of</b> 1. 2.	Introd Perfor Hrs) Introd Job c projec operat Introd follow <b>Experi</b> Establ Line o	uction to <b>wood</b> m Planing operations to <b>fittin</b> consisting of tion,holes on b ions to be performed uction to <b>sheet</b> ing operations <b>ments [Civil]:</b> ishing verticali- put building pla	anical]: working,the hand eration,Cutting by a g shop tools, equip male and femal oth and their asser prmed:Marking,Put t metal work : Job : Marking,Cutting,t ty right angle corner n on site (2 Hrs)	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b> pending/folding (4 Hrs.)	o <b>den job</b> [Squa roove, another ng. Edge filing op v as per given j	with matching perations (6 Hrs.) ob drawing with					
1. 2. 3. <b>List of</b> 1. 2.	Introd Perfor Hrs) Introd Job c projec operat Introd follow <b>Experi</b> Establ Line o Estima	uction to <b>wood</b> m Planing operations onsisting of tion,holes on b ions to be performed uction to <b>sheet</b> ing operations <b>iments [Civil]:</b> ishing verticalition to building plat ate quantities/	anical]: working,the hand eration,Cutting by of g shop tools, equip male and femal oth and their asser ormed:Marking,Put t metal work : Job : Marking,Cutting,t	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b> pending/folding (4 Hrs.)	o <b>den job</b> [Squa roove, another ng. Edge filing op v as per given j	with matching perations (6 Hrs.) ob drawing with					
1. 2. 3. <b>List of</b> 1. 2.	Introd Perfor Hrs) Introd Job c projec operat Introd follow <b>Experi</b> Establ Line o Estima a) Bri	uction to <b>wood</b> m Planing operations onsisting of tion,holes on b ions to be performed uction to <b>sheet</b> ring operations <b>iments [Civil]:</b> ishing verticality out building plat ate quantities/ rickwork	anical]: working,the hand eration,Cutting by or g shop tools, equip male and femal oth and their assert ormed:Marking,Put t metal work : Job : Marking,Cutting,t ty right angle corner n on site (2 Hrs) material (4Hrs)	tools required and machines chisel to prepare small <b>wo</b> ment/machines: <b>e parts</b> viz.one with gr nbly, as per given job drawi nching,Sawcutting,Drilling, of small <b>sheet metal tray</b> pending/folding (4 Hrs.)	o <b>den job</b> [Squa roove, another ng. Edge filing op v as per given j	with matching perations (6 Hrs.) ob drawing with					
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	Useful Links
1	Useful Links https://www.vlab.co.in/broad-area-mechanical-engineering
 1 2	Useful Links https://www.vlab.co.in/broad-area-mechanical-engineering https://drive.google.com/file/d/1tp5yV2ghp_Slub58S7iKnvvJyoEwQVYq/view
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						CO-]	PO Ma	pping							
		Programme Outcomes (PO) Mechanical										PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1				1											
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		Programme Outcomes (PO) Civil										PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1				1											
CO2				1											
CO3					1										

		Programme Outcomes (PO) Electrical											PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1				1											
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	Assessn	nent	
<b>A</b>			aluation.
Based on	Conducted by	Typical Schedule (for 26-week	Marks
		Sem)	
Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 6 Marks Submission at the end of Week 6	30
Lab activities, attendance, journal	Lab Course Faculty	During Week 7 to Week 12 Marks Submission at the end of Week 12	30
Lab activities, attendance, journal	Lab Course Faculty	During Week 15 to Week 18 Marks Submission at the end of Week 18	40
	Lab activities, attendance, journal Lab activities, attendance, journal	Components of lab assessment, LA1, LABased onConducted byLab activities, attendance, journalLab Course FacultyLab activities, attendance, journalLab Course Faculty	Lab activities, attendance, journalLab Course FacultyDuring Week 1 to Week 6 Marks Submission at the end of Week 6Lab activities, attendance, journalLab Course FacultyDuring Week 7 to Week 12 Marks Submission at the end of Week 12Lab activities, attendance, journalLab Course FacultyDuring Week 7 to Week 12 Marks Submission at the end of Week 12Lab activities, attendance, journalLab Course FacultyDuring Week 15 to Week 18 Marks Submission at the end of

Week I indicates starting week of a semester. The typical schedule of lab assessments is shown, considering a 26-week semester. The actual schedule shall be as per academic calendar. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments.